

### MAX17616/MAX17616A

### **Product Highlights**

- Robust Protection Reduces System Downtime
  - Wide Input Supply Range: +3V to +80V (without Reverse Current Protection)
  - Wide Input Supply Range: +3V to +75V (with Reverse Current Protection)
  - ±3% Accurate Programmable Current Limit between 3A to 7A across Full Temperature Range
  - ±4% Accurate Programmable Current Limit between 2A to 3A across Full Temperature Range
  - ±7% Accurate Programmable Current Limit between 0.7A to 2A across Full Temperature Range
  - Input-Voltage Reverse-Polarity Protection (with External nFET)
  - Dual Stage Reverse Current Protection (with External nFET) with Fast 100ns Response Time
  - Low R<sub>ON</sub> Internal nFET (20mΩ typ)
  - · Output-Voltage Reverse-Polarity Tolerant
  - · Loss of Ground Protection
  - · 200% Short Term Overload capability
  - Programmable Overvoltage Surge Protection (MAX17616A)
- PMBus Interface
  - Real Time Operating Conditions Monitoring, Voltage and Current Readout
  - · Fault Registry Access and Management
  - · Device ON/OFF Control
  - · Current Limit Mode Selection
  - · Startup Inrush Current Limit Selection
  - Short Term Over Current Limit and Time Selection
- Flexible Design to Maximize Reuse and Minimize Requalification
  - · Adjustable UVLO and OVLO/OVFB Thresholds
  - ±2% Accurate Bandwidth Current Monitoring Read-Out, IMON (3A to 7A, up to +85°C)
  - · Programmable Startup Inrush Current Limit
  - Programmable Current Limit Fault Response: Continuous, Autoretry, and Latch-off Modes
  - Logic Level Enable Input (EN)
  - Protected External n-type field effect transistor (nFET) Gate Drive

- Power Good Output (PGOOD)
- Programmable Output Under Voltage Sense (OUTUV)
- Junction Temperature Monitoring (T<sub>J</sub>)
- · Thermal Foldback Current Limit
- Reduced Solution Footprint
  - 4.5mm x 5.75mm, 23-Pin FCQFN package
  - Integrated nFET for Common-Use Protection Requirements

### **Key Applications**

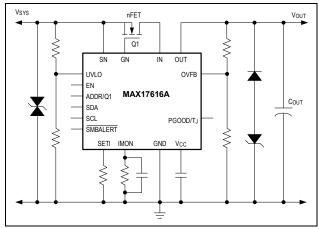
- Input Voltage and Output Overcurrent Protections: The MAX17616/MAX17616A interrupts load current and disconnects the output from the input in input voltage faults and output overcurrent faults.
- · Loss of Ground Protection:

The MAX17616/MAX17616A interrupts load current and disconnects the output from the input in a Loss of Ground event, such as when the single-fault safety fuse on its ground path opens up.

• Surge Protection:

The MAX17616A features an output voltage limiting regulation during transient surges in input voltage to protect connected loads from short-duration input voltage surge events.

## **Simplified Application Diagram**



Ordering Information appears at end of data sheet

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|  |    |

## MAX17616/MAX17616A

# 3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

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# 3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

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### **Absolute Maximum Ratings**

| IN to GNI            | D                     |             |           | 0.3                     | V to + | +85V  |
|----------------------|-----------------------|-------------|-----------|-------------------------|--------|-------|
|                      |                       |             |           | ent Prote<br>85         |        |       |
|                      |                       | `           |           | Protection<br>85        |        |       |
| OUT to G             | ND                    |             |           | 85                      | V to 1 | +85V  |
| IN to OU             | Γ (DC)                |             |           | 0.3                     | V to + | +85V  |
| UVLO, O              | VLO, OV               | FB, SMBALE  | ERT to GN | ID0.3                   | V to + | +33V  |
| EN, PGO              | OD/T <sub>J</sub> , S | SDA, SCL, A | DDR to G  | ND0                     | 3V to  | +6V   |
| V <sub>CC</sub> to G | ND                    |             |           | 0                       | .3V to | +2V   |
| SETI, IMO            | ON to GN              | ۱D          |           | 0.3V to (V <sub>0</sub> | cc + 0 | ).3)V |

| GN to SN  | 0.3V to +10V   |
|---|----------------|
| GN to GND   | 85V to +85V    |
| IN to SN  | 1V to +85V     |
| IN Current (DC)   | 8A             |
| Continuous Power Dissipation ( $T_A = 36.5 \text{mW}/^{\circ}\text{C}$ above +70°C) | •              |
| Operating Temperature Range   | 40°C to +125°C |
| Junction Temperature ((Note 1))   | 40°C to +150°C |
| Storage Temperature   | 65°C to +150°C |
| Lead Temperature (Soldering, 10sec)   | +300°C         |
| Soldering Temperature (Reflow)  | +260°C         |

Note 1: Junction temperature greater than +125°C degrades operating lifetimes.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Package Information**

| Package Code F234A5   |                  |  |  |  |
|---|------------------|--|--|--|
| Outline Number  | <u>21-100606</u> |  |  |  |
| Land Pattern Number 90-100213                                   |                  |  |  |  |
| THERMAL RESISTANCE, FOUR-LAYER BOARD                            |                  |  |  |  |
| Junction-to-Ambient (θ <sub>JA</sub> ) 27.38°C/W                |                  |  |  |  |
| Junction-to-Case Thermal Resistance (θ <sub>JC</sub> ) 1.81°C/W |                  |  |  |  |

For the latest package outline information and land patterns (footprints), go to <a href="https://www.analog.com/en/design-center/packaging-quality-symbols-footprints/package-index.html">https://www.analog.com/en/design-center/packaging-quality-symbols-footprints/package-index.html</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <a href="https://www.analog.com/en/technical-articles/thermal-characterization-of-ic-packages.html">https://www.analog.com/en/technical-articles/thermal-characterization-of-ic-packages.html</a>.

### **Electrical Characteristics**

 $(V_{IN} = V_{SN} = 3V \text{ to } 80V, \text{ GN} = \text{OPEN}, \text{UVLO}, \text{OVLO/OVFB}, \text{EN}, \text{IMON} = \text{OPEN}, \text{PGOOD/T}_J, \overline{\text{SMBALERT}}, \text{SDA}, \text{SCL}, \text{ADDR} = \text{GND}, \text{R}_{SETI} = 2.13k\Omega, V_{CC} = 2.2\mu\text{F to GND}, T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical Values are  $V_{IN} = 48V$ ,  $T_A = +25^{\circ}\text{C}$  (See *Note 2*)

| (See <u>Note 2</u> )  PARAMETER         | SYMBOL                 | CONDITIONS   | MIN   | TYP  | MAX   | UNITS |
|---|------------------------|--|-------|------|-------|-------|
| Input Section                           | J                      |  |       | •••  |       | 1 00  |
|   |                        | Without Reverse Current Protection                                       | 3     |      | 80    |       |
| IN Voltage Range                        | $V_{IN}$               | With Reverse Current Protection  | 3     |      | 75    | V     |
| Shutdown IN Current                     | I <sub>INSHDN</sub>    | V <sub>EN</sub> = 0V, V <sub>OUT</sub> = GND,<br>T <sub>A</sub> = +125°C |       | 20   | 80    | μA    |
|   |                        | V <sub>EN</sub> = 0V, V <sub>OUT</sub> = GND,<br>T <sub>A</sub> = +85°C  |       | 20   | 50    | μA    |
| Shutdown SN<br>Current                  |                        | V <sub>EN</sub> = 0V, V <sub>SN</sub> = -80V                             |       | -53  | -105  | μΑ    |
| Shutdown IN to OUT<br>Current           |                        | V <sub>EN</sub> = 0V, V <sub>IN</sub> - V <sub>OUT</sub> = 80V           |       | 30   | 110   | μA    |
| Shutdown IN, GN, SN shorted             |                        | V <sub>EN</sub> = 0V, V <sub>OUT</sub> = GND, T <sub>A</sub> = +125°C    |       | 30   | 90    | μA    |
|   |                        | $V_{EN} = 0V$ , $V_{OUT} = GND$ , $T_A = +85$ °C                         |       | 30   | 60    | μA    |
| Supply Current                          | I <sub>IN</sub>        |  |       | 2    | 3     | mA    |
| Internal IN Undervoltage                | V <sub>INUVLOR</sub>   | V <sub>IN</sub> Rising   | 2.74  | 2.80 | 2.86  | V     |
| Trip level                              | V <sub>INUVLOF</sub>   | V <sub>IN</sub> Falling  | 2.64  | 2.70 | 2.76  | V     |
| Enable (EN)                             |                        |  |       |      |       |       |
| EN Input-Logic<br>High                  | V <sub>ENH</sub>       |  | 1.4   |      |       | V     |
| EN Input-Logic<br>Low                   | V <sub>ENL</sub>       |  |       |      | 0.4   | V     |
| EN Internal Pullup<br>Voltage           |                        | 3V < V <sub>IN</sub> < 80V   | 1.3   |      | 2.05  | V     |
| EN Input Current                        |                        | V <sub>EN</sub> = 5V   |       |      | 20    | μΑ    |
| EN Pullup<br>Current                    |                        | V <sub>EN</sub> = 0V   | 2.74  | 5    | 9.56  | μA    |
| V <sub>CC</sub> (LDO)                   |                        |  |       |      |       |       |
| V <sub>CC</sub> Output Voltage<br>Range | V <sub>CC</sub>        | 1mA < I <sub>VCC</sub> < 10mA  | 1.7   | 1.8  | 1.86  | V     |
| V <sub>CC</sub> UVLO                    | $V_{CC\_UVR}$          | V <sub>CC</sub> rising   | 1.62  | 1.66 | 1.7   | .,    |
| ACC AAFO                                | V <sub>CC_UVF</sub>    | V <sub>CC</sub> falling  | 1.54  | 1.58 | 1.62  | V     |
| V <sub>CC</sub> current limit           | lvcc                   |  | 15    | 29   | 48    | mA    |
| Undervoltage Lockout (l                 | JVLO)                  |  |       |      |       |       |
| 15.4 G FI                               |                        | UVLO Rising  | 0.911 | 0.93 | 0.948 | .,    |
| UVLO Threshold                          |                        | UVLO Falling   | 0.882 | 0.90 | 0.918 | V     |
| UVLO Leakage<br>Current                 | luvlo_leak             | V <sub>UVLO</sub> = 1V, T <sub>A</sub> = +25°C                           | -100  |      | +100  | nA    |
| Overvoltage Lockout (O                  | VLO) (MAX1761          | 6 only)  |       |      |       |       |
| OVI O Throat ald                        |                        | OVLO Rising  | 0.911 | 0.93 | 0.948 |       |
| OVLO Threshold                          |                        | OVLO Falling   | 0.882 | 0.90 | 0.918 | V     |
| OVLO Leakage<br>Current                 | I <sub>OVLO_LEAK</sub> | V <sub>OVLO</sub> = 1V, T <sub>A</sub> = +25°C                           | -100  |      | +100  | nA    |

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| (See <u>Note 2)</u> PARAMETER                     | SYMBOL                  | COND  | ITIONS   | MIN   | TYP                  | MAX   | UNITS |
|---|-------------------------|---|--|-------|----------------------|-------|-------|
| Output Overvoltage Clar                           | mp (OVFB) (MA           | X17616A only)   |  |       |                      |       |       |
| Overvoltage Clamp<br>Reference                    | OVFB <sub>REF</sub>     |   |  | 0.784 | 0.800                | 0.816 | V     |
| Overshoot on OVFB                                 |                         | IN Slew Rate < 0.1V/μs  | C <sub>LOAD</sub> = 4.7μF,<br>I <sub>LIM</sub> = 7A, I <sub>LOAD</sub> =<br>1A |       | 0                    |       | - mV  |
|   | IN Slew Rate <<br>1V/μs | C <sub>LOAD</sub> = 4.7μF,<br>I <sub>LIM</sub> = 7A, I <sub>LOAD</sub> =<br>1A  |  | 0     |                      | 1110  |       |
| <b>Current Limit and Monite</b>                   | oring (SETI and         | IMON)   |  |       |                      |       |       |
| Current Limit<br>Adjustment Range                 | I <sub>LIM</sub>        |   |  | 0.7   |                      | 7.0   | Α     |
|   |                         | 0.7A < I <sub>LIM</sub> < 2A  |  | -7    |                      | +7    |       |
| Current Limit Threshold                           | I <sub>LIM_ACC</sub>    | 2A ≤ I <sub>LIM</sub> < 3A  |  | -4    |                      | +4    | %     |
| Accuracy  |                         | 3A ≤ I <sub>LIM</sub> ≤ 7A  |  | -3    |                      | +3    |       |
| Overcurrent Response<br>Time                      | tsoc                    | I <sub>LIM</sub> = 1A, I <sub>OUT</sub> step<br>Time to regulate I <sub>OU</sub>  |  |       | 20                   |       | μs    |
| Short-Term Over<br>Current Limit                  | I <sub>STLIM</sub>      |   |  |       | 2 x I <sub>LIM</sub> |       | Α     |
| Short-Term Over<br>Current Limit Blanking<br>Time | tsтос                   |   |  |       | 400                  |       | μs    |
| Overcurrent Protection<br>Threshold               | locp                    | (See <u>Figure 16</u> in the <u>Short Circuit</u> <u>Protection</u> Section)  | (See <u>Note 3</u> )   | 22    | 30                   | 36    | А     |
| Overcurrent Protection<br>Response Time           | t <sub>OCP</sub>        | I <sub>LIM</sub> = 7A, I <sub>OUT</sub> step from 3.5A to 40A, Time to turn off the switch once I <sub>OUT</sub> > I <sub>OCP</sub> | (See <u>Note 3</u> )   |       | 1                    |       | μs    |
|   |                         | 0.7A < I <sub>LIM</sub> < 2A  | I <sub>OUT</sub> < I <sub>LIM</sub>  | -6    |                      | +6    |       |
|   |                         | 2A ≤ I <sub>LIM</sub> < 3A  | I <sub>OUT</sub> < I <sub>LIM</sub>  | -3    |                      | +3    |       |
| IMON Accuracy                                     | I <sub>MON_ACC</sub>    | 3A ≤ I <sub>LIM</sub> ≤ 7A  | I <sub>OUT</sub> < I <sub>LIM</sub> ,<br>T <sub>A</sub> = +125°C               | -2.5  |                      | +2.5  | %     |
|   |                         | JA = ILIM = 7A  | I <sub>OUT</sub> < I <sub>LIM</sub> ,<br>T <sub>A</sub> = +85°C                | -2    |                      | +2    |       |
| IMON Range  |                         |   |  | 0     |                      | 1.25  | V     |
| SETI/IMON Current<br>Ratio                        |                         |   |  |       | 21300                |       | A/A   |
| SETI Clamp  |                         |   |  | 1.59  |                      | 1.81  | V     |
| IMON Clamp  |                         |   |  | 1.49  |                      | 1.69  | V     |
| SETI Fault  |                         |   |  |       | 400                  |       | mV    |
| SETI Resistance                                   |                         | I <sub>LIM</sub> = 7A   |  | 2.13  |                      |       | kΩ    |
| SETI Regulation<br>Voltage                        |                         |   |  |       | 0.7                  |       | V     |
| SETI Range  |                         |   |  | 0     |                      | 1.4   | V     |

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| (See Note 2)  |                          |  |     |         |      |       |
|---|--------------------------|--|-----|---------|------|-------|
| PARAMETER   | SYMBOL                   | CONDITIONS   | MIN | TYP     | MAX  | UNITS |
| Reverse Current Protec                                  | tion                     |  |     |         |      |       |
| Slow Reverse Current<br>Blocking Threshold              | V <sub>RIB_SLOW</sub>    | (V <sub>IN</sub> – V <sub>OUT</sub> ) falling  | -1  | -5      | -10  | mV    |
| Slow Reverse Current Blocking Response Time             | t <sub>RIB_SLOW</sub>    | (See <u>Figure 1</u> ), CGN-SN = 20nF  |     | 20      | 30   | μs    |
| Fast Reverse Current Blocking Threshold                 | V <sub>RIB_FAST</sub>    | (V <sub>IN</sub> – V <sub>OUT</sub> ) falling  | -70 | -100    | -130 | mV    |
| Fast Reverse Current Blocking Response Time             | <sup>t</sup> RIB_FAST    | (See <u>Figure 2</u> ), CGN-SN = 20nF  |     | 100     | 160  | ns    |
| Reverse Current<br>Blocking Rising<br>Threshold Voltage | V <sub>RIB_RISING</sub>  | (V <sub>SN</sub> – V <sub>OUT</sub> ) Rising   | 70  | 100     | 130  | mV    |
| Reverse Output Current drawn from OUT                   | I <sub>OUT_REV</sub>     | V <sub>SN</sub> = 0V, V <sub>OUT</sub> = 48V, IN = OPEN  |     |         | 9    | mA    |
| Gate Drive (GN, SN)                                     |                          |  |     |         |      |       |
| External Reverse Protection nFET Gate Drive Voltage     | V <sub>GN_SN</sub>       | EN = High, No-<br>Fault Condition V <sub>IN</sub> ≥ 10V  | 6   | 6.5     | 7    | V     |
| Gate Active Pullup<br>Current                           |                          | EN = High, $V_{GN} = V_{SN}$ , No Reverse Fault Condition  | 80  | 100     | 120  | μA    |
| Gate Pulldown<br>Resistance                             |                          | EN = High, External nFET OFF  Always present   |     | 60<br>3 | 120  | Ω     |
| Internal FET  |                          | 7 ways prosent   |     |         |      | 14122 |
| Internal nFET ON Resistance                             | R <sub>ON</sub>          | I <sub>LOAD</sub> = 100mA  |     | 20      | 40   | mΩ    |
| Power Good Output (PG                                   | OOD/T <sub>J</sub> )     |  | •   |         |      | •     |
| Logic-Low Voltage                                       |                          | I <sub>SINK</sub> = 1mA  |     |         | 0.4  | V     |
| Leakage Current   |                          | V <sub>PULLUP</sub> = 5V, PGOOD/T <sub>J</sub> Open-Drain<br>OFF   |     |         | 1    | μA    |
| Junction Temperature N                                  | nonitoring (PGO          | OD/T <sub>J</sub> )  |     |         |      |       |
| Accuracy  |                          | T <sub>A</sub> = +25°C   | -9  |         | 9    | °C    |
| T voltage   |                          | $T_A$ = +25°C, $R_{TJ}$ = 10kΩ to GND  |     | 652     |      |       |
| T <sub>J</sub> voltage                                  |                          | $T_A$ = +125°C, $R_{TJ}$ = 10kΩ to GND   |     | 854     |      | mV    |
| dV/dTemp  |                          | T <sub>A</sub> = +25°C to +125°C   |     | 2       |      | mV/°C |
| T <sub>J</sub> Current Limit                            |                          |  | 100 |         | 600  | μΑ    |
| Timing characteristics                                  |                          |  |     |         |      |       |
| IN Debounce Time  | t <sub>DEB</sub>         | Time from V <sub>IN</sub> > V <sub>UVLO_R</sub> and Internal FET turn-on starts                          | 0.9 | 1       | 1.1  | ms    |
| INUVLO Blanking Time                                    | <sup>†</sup> INUVLOBLANK | Power-up SMBALERT assertion blanking time  |     | 0.5     |      | ms    |
| EN Turn-On Time   |                          | Delay from EN = 1 for the part to turn on Internal FET (provided V <sub>IN</sub> > V <sub>UVLO_R</sub> ) |     | 2.5     |      | ms    |
| Internal nFET Turn-On Time                              | ton_switch               | From No Fault to I <sub>OUT</sub> = 1A   |     | 150     |      | μs    |

### MAX17616/MAX17616A

# 3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

 $(V_{IN} = V_{SN} = 3V \text{ to } 80V, \text{ GN} = \text{OPEN}, \text{UVLO}, \text{OVLO/OVFB}, \text{EN}, \text{IMON} = \text{OPEN}, \text{PGOOD/T}_J, \overline{\text{SMBALERT}}, \text{SDA}, \text{SCL}, \text{ADDR} = \text{GND}, R_{SETI} = 2.13k\Omega, V_{CC} = 2.2\mu\text{F to GND}, T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}, \text{ unless otherwise noted}. \text{Typical Values are } V_{IN} = 48V, T_A = +25^{\circ}\text{C}$  (See *Note 2*)

| (See <u>Note 2)</u> PARAMETER               | SYMBOL                | CONI  | DITIONS  | MIN  | TYP  | MAX  | UNITS |
|---|-----------------------|---|--|------|------|------|-------|
| Delay between Internal                      |                       |   |  |      |      |      | 00    |
| nFET Turn-On and                            | $t_{DR}$              |   |  | 90   | 100  | 110  | μs    |
| External nFET Turn-On                       |                       |   |  |      |      |      | -     |
| The delay between                           |                       |   |  |      |      |      |       |
| Internal nFET Turn-OFF and External nFET    | $t_{DF}$              |   |  | 90   | 100  | 110  | μs    |
| Turn-OFF                                    |                       |   |  |      |      |      |       |
| Undervoltage Lock Out Turn OFF Time         | t <sub>OFF_UVLO</sub> | V <sub>UVLO</sub> falling from              | 1V to 0.8V   |      | 1    |      | μs    |
| Overvoltage Lock Out                        | to== 0\# 0            | V <sub>OVLO</sub> rising from (             | ) 8\/ to 1\/   |      | 4    |      |       |
| Turn OFF Time                               | toff_ovlo             | VOVEO rising from C                         | 7.0 V 10 1 V   |      | 1    |      | μs    |
| Undervoltage Lock Out                       |                       | V rigina                                    |  |      |      |      |       |
| Rising Edge Debounce<br>Time                | <sup>t</sup> DEB_UVLO | V <sub>IN</sub> rising                      |  |      | 10   |      | μs    |
| Overvoltage Lock Out                        | to-50 00 % 0          | V <sub>IN</sub> falling                     |  |      | 40   |      |       |
| Falling Edge Debounce<br>Time               | tDEB_OVLO             | VIN familing                                |  |      | 10   |      | μs    |
| Auto Retry Tme                              | t <sub>RETRY</sub>    |   |  |      | 800  |      | ms    |
| Blanking Time                               | <sup>t</sup> BLANK    |   |  | 21.8 | 24.0 | 26.4 | ms    |
| Startup Timeout                             | t <sub>STO</sub>      |   |  | 1080 | 1200 | 1320 | ms    |
| Loss of Ground Switch Turn OFF Time         |                       | C <sub>VCC</sub> = 2.2μF                    |  |      | 100  |      | ms    |
| ADC and Variables Read                      | l Out (PMBus)         |   |  |      |      |      |       |
| Resolution                                  |                       |   |  |      | 12   |      | bits  |
| V <sub>SN</sub> , V <sub>OUT</sub> Range    |                       |   |  | 3    |      | 80   | V     |
| ., .,                                       |                       | 3V ≤ V <sub>SN</sub> , V <sub>OUT</sub> ≤ 1 | 12V  | -3.5 |      | +3.5 |       |
| V <sub>SN</sub> , V <sub>OUT</sub> Accuracy |                       | 12V < V <sub>SN</sub> , V <sub>OUT</sub> <  | : 80V  | -1.5 |      | +1.5 | %     |
| I <sub>OUT</sub> Range                      |                       |   |  | 0.7  |      | 7.0  | Α     |
|   |                       | 0.7A ≤ I <sub>OUT</sub> < 2A                | I <sub>OUT</sub> < I <sub>LIM</sub> ,                              |      |      |      |       |
|   |                       | 0.7A \$ 10UT \ 2A                           | C <sub>IMON</sub> = 100nF  | -6   |      | +6   |       |
|   |                       | 2A ≤ I <sub>OUT</sub> < 3A                  | I <sub>OUT</sub> < I <sub>LIM</sub> ,<br>C <sub>IMON</sub> = 100nF | -3   |      | +3   |       |
| I <sub>OUT</sub> Accuracy                   |                       | 3A ≤ I <sub>OUT</sub> ≤ 7A                  | $I_{OUT} < I_{LIM}$ ,<br>$C_{IMON} = 100$ nF,<br>$T_A = +125$ °C   | -2.5 |      | +2.5 | %     |
|   |                       | 3A = 1001 = 7A                              | $I_{OUT} < I_{LIM}, C_{IMON}$<br>= 100nF, $T_A$ =<br>+85°C         | -2   |      | +2   |       |
| True I <sub>OUT</sub> Range =               |                       |   |  | 0    |      | 1.25 | V     |
| ADC Full Scale                              |                       |   |  |      |      |      |       |
| T <sub>J</sub> Range                        |                       | T .0500                                     |  | 0    |      | 150  | °C    |
| T <sub>J</sub> Accuracy                     |                       | T <sub>A</sub> = +25°C                      |  | -9   |      | +9   | °C    |
| Sampling Rate                               |                       |   |  |      | 2500 |      | Hz    |
| PMBus Interface Specific                    |                       | <u> </u>                                    | Т  |      |      |      | 1     |
| Clock Frequency                             | f <sub>CLK</sub>      | (See Note 3)                                |  |      |      | 1000 | kHz   |
| Bus Free Time between STOP and START        | t <sub>BUF</sub>      |   |  | 0.5  |      |      | μs    |

### MAX17616/MAX17616A

# 3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

 $(V_{IN} = V_{SN} = 3V \text{ to } 80V, \text{ GN} = \text{OPEN}, \text{UVLO}, \text{OVLO/OVFB}, \text{EN, IMON} = \text{OPEN}, \text{PGOOD/T}_J, \overline{\text{SMBALERT}}, \text{SDA, SCL, ADDR} = \text{GND}, R_{SETI} = 2.13k\Omega$ ,  $V_{CC} = 2.2\mu\text{F}$  to GND,  $T_A = -40^{\circ}\text{C}$  to +125°C, unless otherwise noted. Typical Values are  $V_{IN} = 48V$ ,  $T_A = +25^{\circ}\text{C}$  (See *Note 2*)

| PARAMETER                                | SYMBOL               | CONDITIONS                                      | MIN  | TYP | MAX | UNITS |
|--|----------------------|---|------|-----|-----|-------|
| Hold Time after Repeated Start Condition | t <sub>HD;STA</sub>  | After this period, the first clock is generated | 0.26 |     |     | μs    |
| Repeated Start<br>Condition Setup Time   | t <sub>SU;STA</sub>  |   | 0.26 |     |     | μs    |
| STOP Condition Setup<br>Time             | tsu;sto              |   | 0.26 |     |     | μs    |
| Data Hold Time                           | t <sub>HD;DAT</sub>  | (See Note 4)                                    | 300  |     |     | ns    |
| Data Setup Time                          | t <sub>SU;DAT</sub>  |   | 100  |     |     | ns    |
| Detect Clock Low Time-<br>out            | t <sub>TIMEOUT</sub> | (See <u>Note 5</u> )                            | 25   |     | 35  | ms    |
| Clock Low Period                         | $t_{LOW}$            |   | 0.5  |     |     | μs    |
| Clock High Period                        | t <sub>HIGH</sub>    | (See Note 6)                                    | 0.5  |     |     | μs    |
| Clock/Data Rise Time                     | t <sub>R</sub>       | (See Note 7)                                    |      |     | 120 | ns    |
| Clock/Data Fall Time                     | t <sub>F</sub>       | (See Note 7)                                    |      |     | 120 | ns    |
| Noise Spike<br>Suppression Time          | t <sub>SPIKE</sub>   | (See Note 8)                                    | 0    |     | 50  | ns    |
| Data, Clock, Input Low<br>Voltage        | $V_{IL}$             |   |      |     | 8.0 | V     |
| Data, Clock, Input High<br>Voltage       | $V_{IH}$             |   | 1.35 |     | 5.5 | V     |
| Data, Output Low<br>Voltage              | $V_{OL}$             |   | 0    |     | 0.4 | V     |
| SCL, SDA input current                   |                      |   | -1   |     | 1   | μA    |
| Thermal Protection                       |                      |   |      |     |     |       |
| Thermal Foldback                         | T <sub>J(FB)</sub>   |   |      | 150 |     | °C    |
| Thermal Shutdown                         | TJ                   |   |      | 165 |     | °C    |
| Thermal Shutdown<br>Hysteresis           | T <sub>J(HYS)</sub>  |   |      | 20  |     | °C    |

- **Note 2:** All devices are 100% production-tested at T<sub>A</sub> = +25°C. Limits over the operating-temperature range are guaranteed by design, not production tested.
- Note 3: Guaranteed by design, not production tested.
- Note 4: A controller shall not drive the clock at a frequency below the minimum f<sub>CLK</sub>. Further, the operating clock frequency shall not be reduced below the minimum value of f<sub>CLK</sub> due to the periodic clock extending by a device. This limit does not apply to the bus idle condition, and this limit is independent from the t<sub>LOW;SEXT</sub>, and t<sub>LOW;MEXT</sub> limits.
- Note 5: Devices participating in a transfer can abort the transfer in progress and release the bus when any single clock low interval exceeds the value of t<sub>TIMEOUT,MIN</sub>. After the controller in a transaction detects this condition, it must generate a stop condition within or after the current data byte in the transfer process. Devices that have detected this condition must reset their communication and be able to receive a new START condition no later than t<sub>TIMEOUT,MAX</sub>. A timeout condition can only be ensured if the device that is forcing the timeout holds the CLK low for t<sub>TIMEOUT,MAX</sub>, or longer.
- **Note 6:** t<sub>HIGH,MAX</sub> provides a simple guaranteed method for controllers to detect bus idle conditions. A controller can assume that the bus is free if it detects that the clock and data signals have been high for greater than t<sub>HIGH,MAX</sub>.
- Note 7: The rise and fall time measurement limits are defined as follows: Rise Time Limits:  $(V_{IL,MAX} 0.15V)$  to  $(V_{IH,MIN} + 0.15V)$  Fall Time Limits:  $(V_{IH,MIN} + 0.15V)$  to  $(V_{IL,MAX} 0.15V)$
- Note 8: Devices must provide a means to reject noise spikes of a duration up to the maximum specified value.

## **Timing Diagrams**

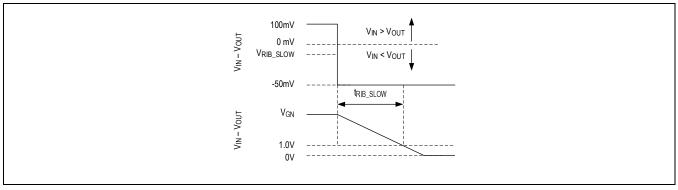


Figure 1. Slow Reverse Current Blocking Response Time

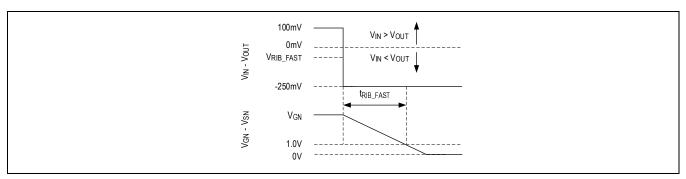
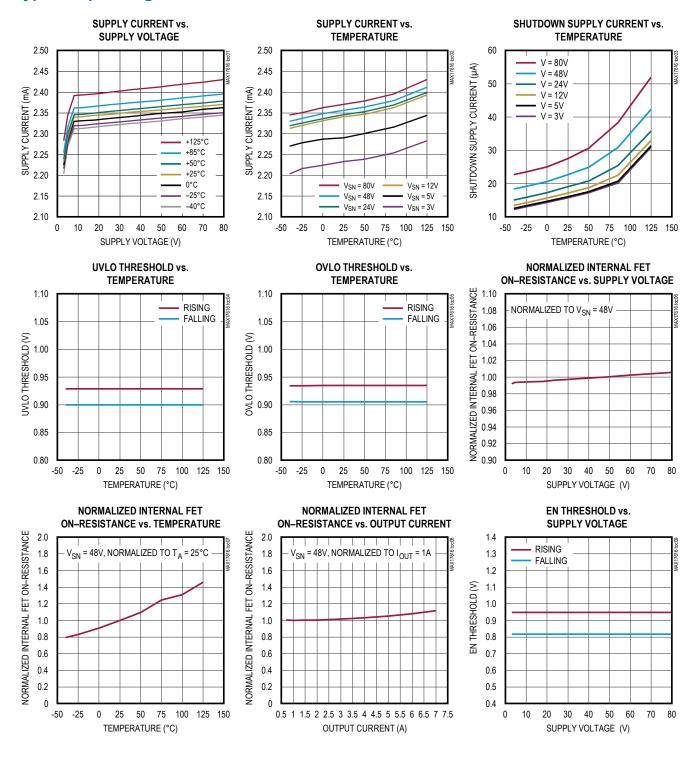
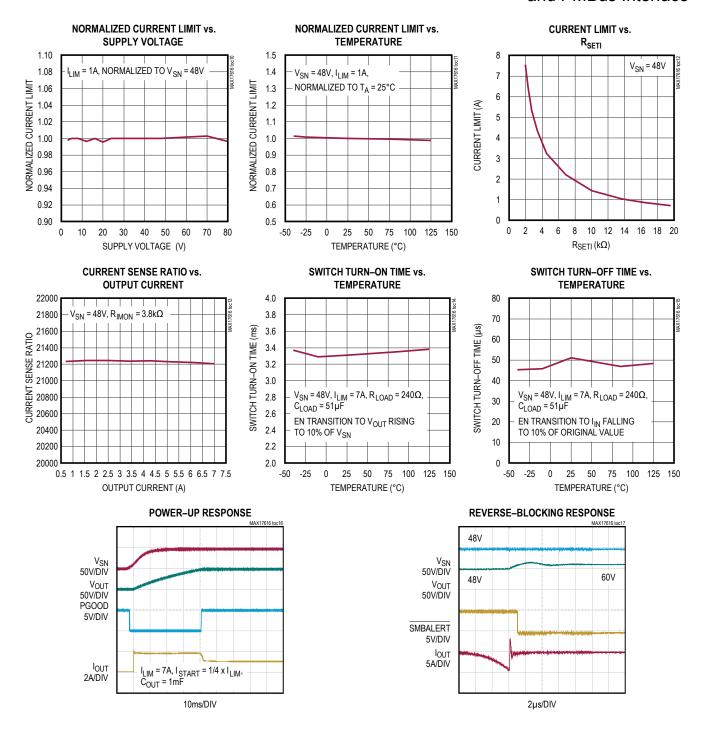
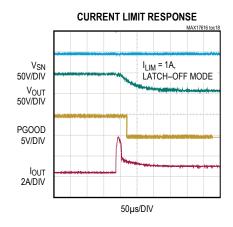


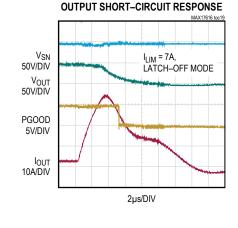
Figure 2. Fast Reverse Current Blocking Response Time

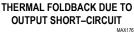
## **Typical Operating Characteristics**

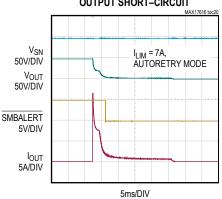


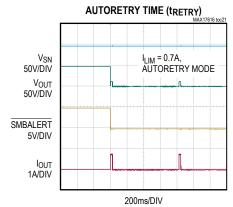


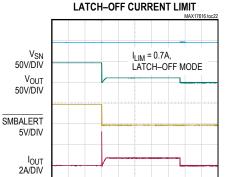




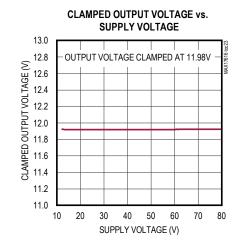


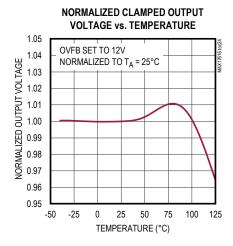


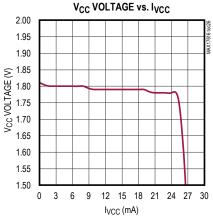


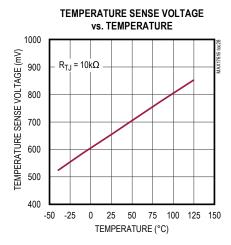


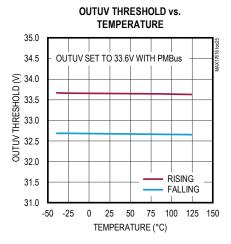
5ms/DIV

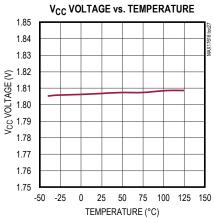


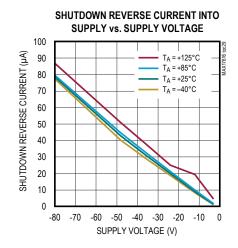


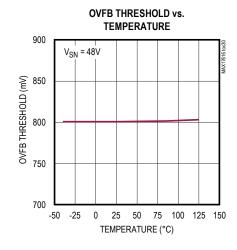


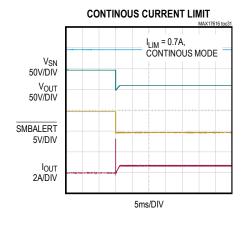


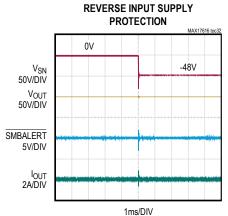


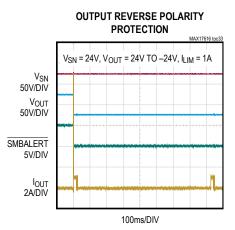




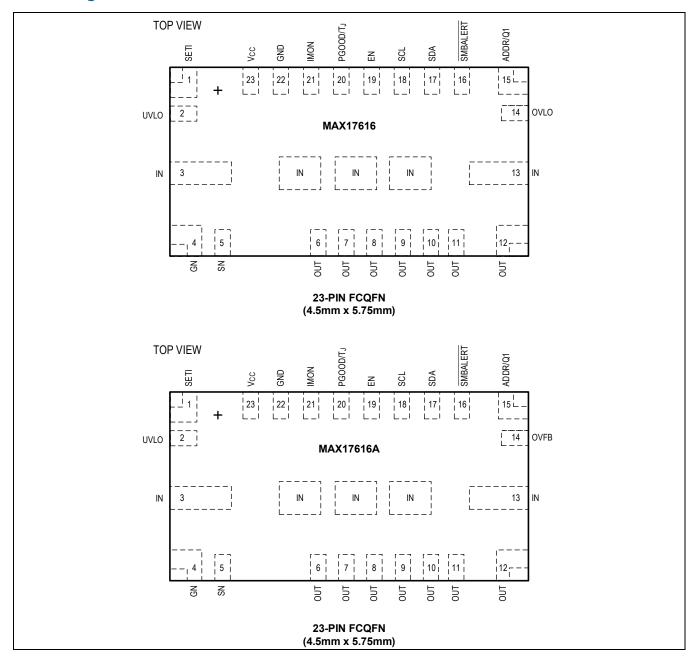








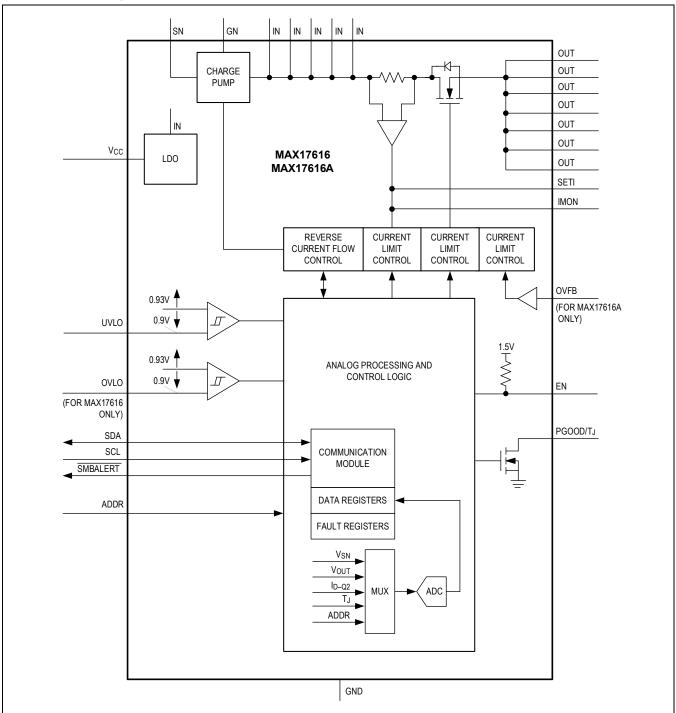
# **Pin Configurations**



# **Pin Descriptions**

| PIN      |           |                          |  |  |  |  |
|----------|-----------|--------------------------|--|--|--|--|
| MAX17616 | MAX17616A | NAME                     | FUNCTION   |  |  |  |
| 1        | 1         | SETI                     | Current Limit Adjustment Pin. Connect a resistor from SETI to GND to set the current limit. See <u>Setting the Current-Limit Threshold</u> section. Do not connect more than 30pF to SETI.   |  |  |  |
| 2        | 2         | UVLO                     | Input Under Voltage Lockout (UVLO) Adjustment Pin. Connect resistive potential divider from SN/IN to GND pin to set the UVLO threshold. Tie UVLO to a voltage higher than the UVLO threshold if the UVLO function is not used.   |  |  |  |
| 3, 13    | 3, 13     | IN                       | Input Pins. For Hot Plug-In applications, see the <u>Applications Information</u> section.   |  |  |  |
| 4        | 4         | GN                       | Gate Driver Output for External Reverse Protection nFET. Connect SN and GN terminals to IN, if external nFET is not used.  |  |  |  |
| 5        | 5         | SN                       | Return for External Reverse Protection nFET and Input Voltage Sense Pin. Connect to the source of external nFET as shown in the <u>Typical Application Circuits</u> . Connect SN and GN terminals to IN, if external nFET is not used.   |  |  |  |
| 6–12     | 6–12      | OUT                      | Output Pins. For a long output cable or inductive load, see the Applications Information section.  |  |  |  |
| 14       | -         | OVLO                     | OVLO Adjustment Pin. Connect resistive potential divider from SN/IN to GND pin to set the OVLO threshold. Connect OVLO to GND to disable the OVLO function.  |  |  |  |
| -        | 14        | OVFB                     | Output Voltage feedback pin for Over Voltage Clamp function. Connect the resistive potential divider from OUT to GND to set the output voltage clamp threshold. Connect OVFB to GND when not used. See the <a href="Input Voltage Surge Stopping and Output">Input Voltage Surge Stopping and Output</a> Overvoltage Feedback Regulation (OVFB) section.   |  |  |  |
| 15       | 15        | ADDR/Q1                  | SMBus device address programming and Reverse Protection FET presence programming pin. Connect a resistor from ADDR to GND to program the device address. See the <u>Device Addressing and Reverse Protection (Q1) Decoding</u> section.  |  |  |  |
| 16       | 16        | SMBALERT                 | Active-Low SMBus Interface Line. Logic output pin. See the <i>Fault Output (SMBALERT)</i> section.   |  |  |  |
| 17       | 17        | SDA                      | SMBus Data Line.   |  |  |  |
| 18       | 18        | SCL                      | SMBus Clock Line.  |  |  |  |
| 19       | 19        | EN                       | Active-High Enable Input. Internally pulled up to 1.5V. Leave unconnected for always-on the operation.   |  |  |  |
| 20       | 20        | PGOOD/<br>T <sub>J</sub> | Open-Drain Power Good Output or Die Temperature Monitor Output. Pull the PGOOD/T <sub>J</sub> to an external bias voltage for the PGOOD function. PGOOD is pulled high when: • V <sub>OUT</sub> exceeds OUTUV rising threshold and (V <sub>IN</sub> –V <sub>OUT</sub> ) satisfies < VFA condition. PGOOD is pulled low when: • V <sub>OUT</sub> falls below OUTUV falling threshold. This pin can also be used to monitor the die temperature. Connect a 10kΩ–20kΩ resistor from PGOOD/T <sub>J</sub> to GND to measure device temperature. See the <u>Die Temperature</u> Monitoring (PGOOD/TJ) for more details. |  |  |  |
| 21       | 21        | IMON                     | Output Pin for Current Monitoring. Connect a resistor from IMON to GND to program the current monitor readout. Connect a 100nF ceramic capacitor from IMON to GND. See the Current Monitoring (IMON) section.  |  |  |  |
| 22       | 22        | GND                      | Ground Pin. Reference pin for all control signals.   |  |  |  |
| 23       | 23        | $V_{CC}$                 | Internal LDO Output. Connect a minimum of 2.2 $\mu$ F/0603, low-ESR ceramic capacitor from V <sub>CC</sub> to GND.   |  |  |  |

## **Functional Diagram**



### **Detailed Description**

The MAX17616/MAX17616A offers highly versatile and programmable protection boundaries for systems against input voltage faults and output overcurrent faults. Input-voltage faults (with positive polarity) are protected up to +80V (without Reverse Current Protection)/+75V (with Reverse Current Protection), by an internal nFET featuring low ON-resistance (20mΩ typ). The devices feature a programmable undervoltage-lockout (UVLO) thresholds by using external voltage-dividers. The MAX17616 features a programmable overvoltage-lockout (OVLO) while MAX17616A offers a programmable output voltage clamp function through the OVFB pin that features an output voltage limiting regulation during input transient surge events. Input undervoltage and overvoltage protection (MAX17616)/output voltage clamp function (MAX17616A) can be programmed across the entire 3V to 80V operating range.

Input reverse-polarity protection is realized using an external nFET that is controlled by the devices. The magnitude of reverse-polarity voltage protection is dependent on the operating load-bus voltage ( $V_{OUT}$ ) and the voltage-blocking capability of the external nFET. For example, for protection down to a -55V input range with  $V_{OUT}$  = 30V, an external nFET rated at 85V is needed. The external nFET is also needed for the optional reverse-current protection. When used with a Reverse Protection external nFET (Q1), the devices prevent reverse current flow from load to source by turning off Q1. The reverse current thresholds and forward bias characteristics of the reverse current protection feature are tuned to achieve an ideal diode function suited for OR-ing and Power Multiplexer applications. If reverse polarity protection and reverse-current protection are not needed, SN and GN pins must be connected to IN. The devices are tolerant against accidental output reverse-polarity application due to incorrect wiring across the output terminals.

The current limit of the devices is programmed by connecting a resistor from the SETI pin to GND. The current limit can be programmed from 0.7A to 7.0A. When the current through the devices reaches or exceeds the set current limit, the resistance of the internal nFET is modulated to limit the current. The devices offer three current-limit behavioral modes: Continuous, Auto-retry, and Latch-off modes. In addition, the devices allow programmable startup inrush current limit during startup events, to prevent inrush current from limited power sources flowing into capacitive or negative impedance output loads.

The IMON pin presents a current proportional to the device current under normal operation. Together with the IMON resistor (between IMON and GND), the IMON pin presents a voltage that is proportional to the device current. This voltage can be read by a monitoring system to record the instantaneous current of the device. Place a 100nF ceramic capacitor from IMON to GND.

The device can be turned ON or OFF by enabling input EN by a controller supervisory system. This allows the controller supervisory system to Turn ON or OFF the power delivery to connected loads.

The devices offer loss-of-ground protection where it safely turns OFF the device operation during a loss-of-ground fault event, i.e., when the safety ground fuse opens in a redundant safety application.

The devices offer a status announcement signal (SMBALERT) to indicate operational and fault signals. The devices also offer a Power Good Signal (PGOOD/T<sub>J</sub>) that may be used by a supervisory system to enable/disable the downstream loads. PGOOD/T<sub>J</sub> is an open drain pin and requires an external pullup resistor to the appropriate system interface.

The devices offer a programmable output undervoltage sense threshold that governs the restart response after the output voltage drops below the OUTUV Rising threshold. The device also offers internal thermal shutdown protection against excessive power dissipation.

The devices offer a PMBus compatible Serial Peripheral Interface, with commands to control the device operation and observe system level parameters.

### Input Undervoltage Lockout (UVLO)

The devices have a UVLO adjustment range from 3V to 79V. Connect an external resistive potential divider to the UVLO pin, as shown in the <u>Figure 3</u>, to adjust the UVLO threshold voltage. Use the following equation to adjust the UVLO threshold. For low-bias current applications, such as a battery supply, the recommended value of R1 is  $2.2M\Omega$ .

$$V_{UVLO} = V_{UVLO\_RISING} x \left( 1 + \frac{R_1}{R_2} \right)$$

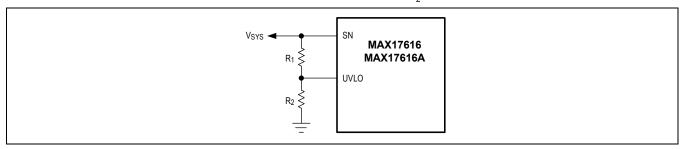


Figure 3. Adjustable Input UVLO

A 30mV (typ) hysteresis is provided on the UVLO pin, thus causing the devices to enter and exit undervoltage conditions in a deterministic manner. When the UVLO pin voltage falls below 0.9V (typ), the internal nFET turns OFF, and  $\overline{\text{SMBALERT}}$  is asserted low. The external nFET, if used, turns OFF after a delay time (tDF) of 100µs. When the Undervoltage condition is removed, and the UVLO pin voltage rises above 0.93V (typ), the devices take undervoltage lockout rising to debounce time (tDEB\_UVLO) to start the switch turn ON process. The internal nFET turns ON, and the external nFET turns ON after a delay time (tDR) of 100µs, and  $\overline{\text{SMBALERT}}$  is de-asserted. The UVLO pin must not be left unconnected.

A typical undervoltage turn-on and turn-off sequence when the voltage on the UVLO pin increases above the rising threshold and decreases below the falling threshold. See *Figure 4* for more details.

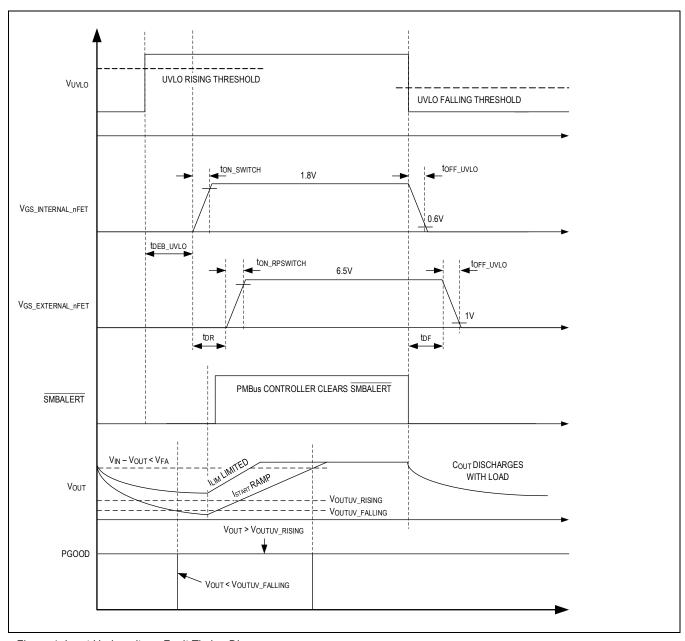


Figure 4. Input Undervoltage Fault Timing Diagram

### Input Overvoltage Lockout (OVLO)

The MAX17616 has an OVLO adjustment range from 3.5V to 80V. Connect an external resistive potential divider to the OVLO pin, as shown in the <u>Figure 5</u>, to adjust the OVLO threshold voltage. Use the following equation to adjust the OVLO threshold. For low-bias current applications, such as a battery supply, the recommended value of R3 is  $2.2M\Omega$ .

$$V_{OVLO} = V_{OVLO\_RISING} x \left( 1 + \frac{R_3}{R_4} \right)$$

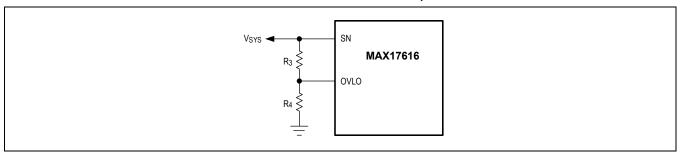


Figure 5. Adjustable Input OVLO

A 30mV (typ) hysteresis is provided on the OVLO pin, thus causing the devices to enter and exit overvoltage conditions in a deterministic manner. When the OVLO pin voltage rises above 0.93V (typ), the internal nFET turns OFF, and  $\overline{\text{SMBALERT}}$  is asserted low. The external nFET, if used, turns OFF after a delay time ( $t_{DF}$ ) of 100 $\mu$ s. When the overvoltage condition is removed, and the OVLO pin voltage falls below 0.9V (typ), the MAX17616 takes overvoltage lockout rising debounce time ( $t_{DEB\_OVLO}$ ) to start the switch turn-on process. The internal nFET turns ON, and the external nFET turns ON after a delay time ( $t_{DR}$ ) of 100 $\mu$ s, and  $\overline{\text{SMBALERT}}$  is de-asserted. If the OVLO function is not used, the OVLO pin must be connected to GND. The OVLO pin must not be left unconnected.

A typical overvoltage turn-off and turn-on sequence when the voltage on the OVLO pin increases above the rising threshold and decreases below the falling threshold. See  $\underline{\textit{Figure 6}}$  for more details.

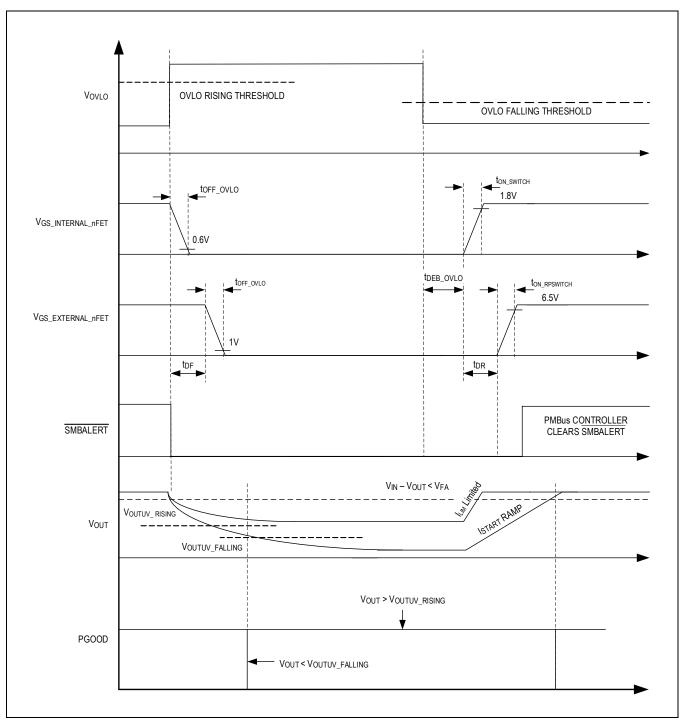


Figure 6. Input Overvoltage Fault Timing Diagram

### **Input Debounce Protection**

The devices provide input debounce protection. The devices start operation (by turning on the nFETs) only if the IN pin voltage is higher than the  $V_{IN\_UVLO(R)}$  rising threshold for a period greater than the debounce time ( $t_{DEB}$ ). If the voltage at the IN pin falls below the  $V_{IN\_UVLO(F)}$  falling threshold before  $t_{DEB}$  has elapsed, the devices remain off. When the devices are turned ON through EN,  $t_{DEB}$  + EN turn-on time is always present. <u>Figure 7</u> shows a typical Input power-up timing sequence.

During initial power up (either hot plug-in, controlled input voltage slew rate, or otherwise), when the input voltage crosses INUVLOR (2.86V Max), If the input voltage does not reach the UVLO pin programmed voltage until INUVLO\_Blanking\_Time ( $t_{INUVLOBLANK}$ ) = 500 $\mu$ s(typ), then the part shall declare UVLO fault by pulling SMBALERT low.

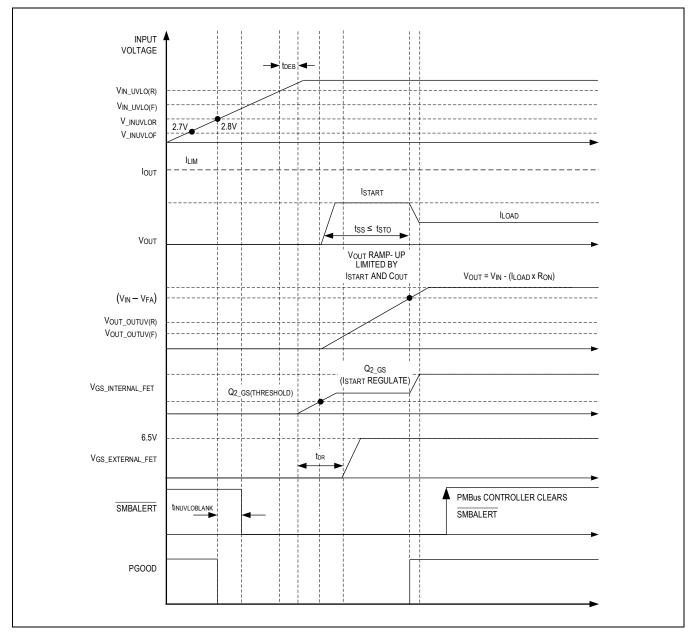
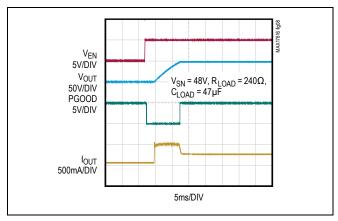


Figure 7. Input Power-up Timing Diagram

### **Enable**

The MAX17616/MAX17616A can be turned ON or OFF using the enable input pin (EN) to control the power delivery to connected loads. The OPERATION command works in conjunction with the EN pin to turn the devices ON or OFF. In Latch-Off Mode, the EN pin must be pulled low below 0.4V for at least 10µs to reset the fault condition and the devices resume operation. The EN pin is internally pulled up to 1.5V to have an always-on option when it is left open.

Figure 8 and Figure 9 show turn-on and turn-off control with EN.



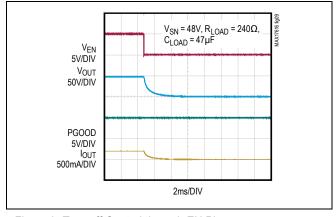


Figure 8. Turn-on Control through EN Pin

Figure 9. Turn-off Control through EN Pin

### Startup Inrush Current Limit (ISTART)

The devices offer a programmable startup inrush current limit feature to limit the inrush current drawn from the power source and delivered to large capacitive loads. During the startup timeout period ( $t_{STO}$ ), the current delivered to the output is limited to  $I_{START}$  when  $V_{OUT} < V_{IN} - V_{FA}$ . The  $t_{STO}$  timeout period is applied when there is a restart after a turn-off event caused by POR, EN, UVLO, or OVLO. If the output is not charged to ( $V_{IN} - V_{FA}$ ) level within  $t_{STO}$ , the devices turn off, and IN or EN must be toggled to resume normal device operation, irrespective of CLMODE selected.

I<sub>START</sub> is programmed using the SET\_ISTART\_RATIO command. The inrush current limit during startup (I<sub>START</sub>) is calculated as:

$$I_{START} = I_{LIM} x I_{START RATIO}$$

where I<sub>I IM</sub> is the current limit programmed using SETI pin and

I<sub>START RATIO</sub> is a value between (1/16, 1/8,1/4,1/2,1).

The startup time for large capacitive loads may be calculated using the following equation:

$$t_{SS} = \frac{V_{IN} \times C_{OUT}}{I_{START}}$$

where t<sub>SS</sub> is the required startup charging time in seconds.

Figure 10 shows a typical Startup Timing Sequence during powerup.

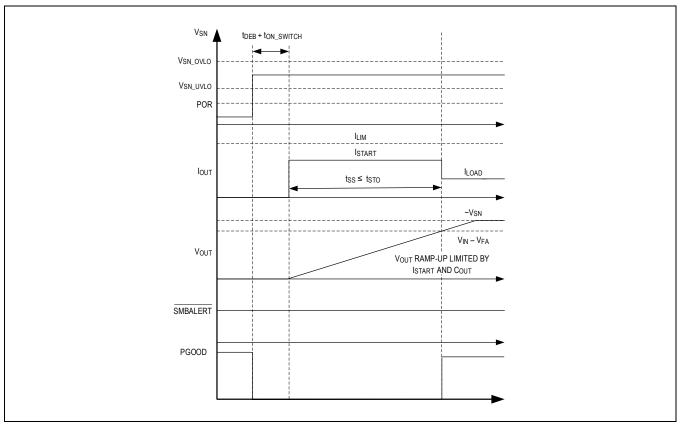


Figure 10. ISTART Timing Diagram

PGOOD remains asserted low during the soft start period. As the output voltage increases, when the voltage drop across the internal nFET (measured across IN and OUT pins) falls below an internal threshold V<sub>FA</sub>, PGOOD is de-asserted.

### Setting the Current-Limit Threshold (I<sub>LIM</sub>)

Connect a resistor between SETI and GND to program the current-limit threshold in the device. Use the following equation to calculate the current limit-setting resistor:

$$R_{SETI}(k\Omega) = \frac{14910}{I_{LIM}(mA)}$$

where I<sub>LIM</sub> is the desired current limit in mA.

Do not use an  $R_{SETI}$  smaller than 1.86k $\Omega$ . <u>Table 1</u> shows current-limit thresholds for different resistor values.

Table 1. Current-Limit Threshold vs. Resistor Values

| R <sub>SETI</sub> (kΩ) | CURRENT LIMIT I <sub>LIM</sub> (A) |
|------------------------|------------------------------------|
| 21.0                   | 0.7                                |
| 14.7                   | 1                                  |
| 7.32                   | 2                                  |
| 4.87                   | 3                                  |
| 3.65                   | 4                                  |
| 2.94                   | 5                                  |
| 2.43                   | 6                                  |
| 2.10                   | 7                                  |

If SETI is left unconnected,  $V_{SETI} \ge 1.5V$ , and the current regulator does not allow any current to flow. The devices perform a check on the SETI pin for the first time, and it exits a shutdown condition. If the resistor placed on SETI is below  $1k\Omega$ , the switch remains off, and the  $\overline{SMBALERT}$  asserts. <u>Figure 11</u> shows the SETI response during a load step event.

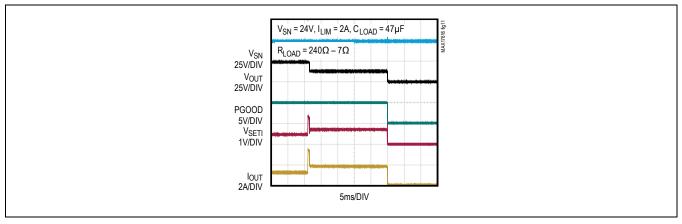


Figure 11. SETI Response during a Load Step Event

### **Current Monitoring (IMON)**

The devices offer a dedicated IMON pin to monitor the load current flowing through the internal nFET.

Connect a 100nF ceramic capacitor from the IMON pin to GND. Connect a resistor ( $R_{IMON}$ ) between IMON and GND to monitor the device current. Use the following equation to calculate the monitoring resistor  $R_{IMON}$ :

$$R_{IMON} = \frac{26625}{I_{IJM}(mA)}$$

where  $R_{IMON}$  is the resistance from IMON to GND in  $k\Omega$ .

The voltage on the IMON pin (V<sub>IMON</sub>) is calculated using the following formula:

$$V_{IMON} = \frac{I_{nFET}}{21300} \times R_{IMON}$$

where I<sub>nFFT</sub> is the load current through the internal FET.

### **Current-Limit and Short-Term Over Current features**

The devices feature Short-Term Over Current Loading Capability (I<sub>STLIM</sub>) to support load current profiles that contain short-term overload currents during normal operation. The I<sub>STLIM</sub> is set to two times the programmed current limit (I<sub>LIM</sub>) on the SETI pin, and the short-term over the current duration(t<sub>STOC</sub>) is set to 400µs.

- 1) If the load current exceeds I<sub>LIM</sub> but stays lower than I<sub>STLIM</sub> for a duration < t<sub>STOC</sub>, the devices do not limit the current, and normal operation continues.
- 2) If the load current exceeds  $I_{LIM}$  but stays lower than  $I_{STLIM}$  for duration >  $t_{STOC}$ , or If the load current exceeds  $I_{STLIM}$  but stays lower than  $I_{OCP}$ , the devices limit the current to the programmed current limit ( $I_{LIM}$ ) within ~100us.

Once the devices enter the current limit (ILIM), the devices' operation is decided by the current limit mode as described in the *Current-Limit Type Select* section.

The short-term over the current limit is set using the SET\_ISTLIM command, and the short-term over the current duration is set using the SET\_TSTOC command.

Figure 12 shows the Current Limit and Short-Term Overcurrent timing diagram.

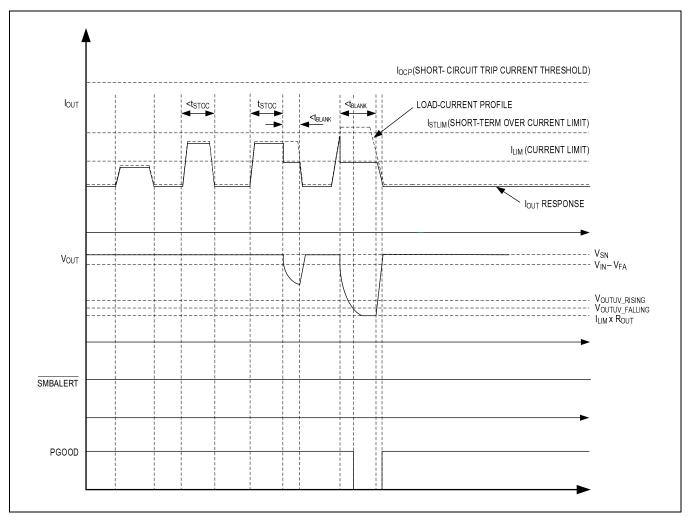


Figure 12. Current Limit and Short-Term Overcurrent Timing Diagram

### **Current-Limit Type Select**

The MAX17616/MAX17616A features three selectable current limit modes, namely, Continuous, Auto-Retry, and Latch-Off modes. The current limit mode is programmed through the SET\_CLMODE PMBus command. If the  $(V_{IN} - V_{OUT} < V_{FA})$  condition is not met within  $t_{STO}$ , the devices enter a Latch-Off state, irrespective of the CLMODE selected.

### **Continuous Current Limit**

In Continuous current-limit mode, the devices limit the current continuously. The  $\overline{\text{SMBALERT}}$  asserts when the current limit exceeds  $t_{BLANK}$  duration, and deasserts when voltage drop across the internal switch falls below  $V_{FA}$ . <u>Figure 13</u> depicts typical behavior in continuous current-limit mode.

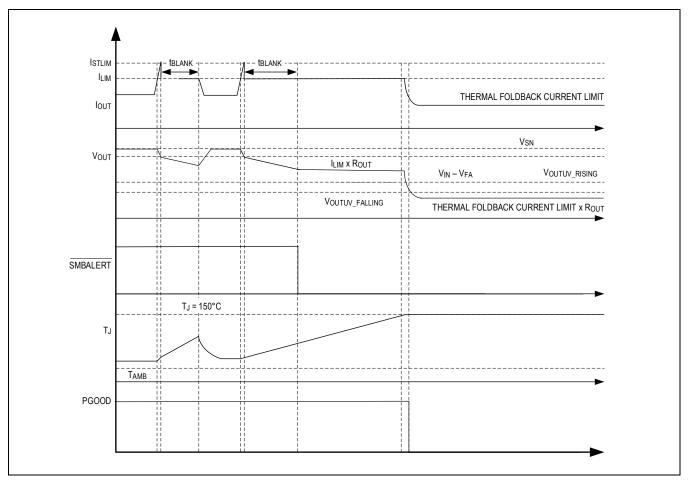


Figure 13. Continuous-Fault Timing Diagram

### **Autoretry Current Limit**

In Autoretry current limit mode, the devices attempt to restart operation after an internally fixed Autoretry period ( $t_{RETRY}$ ). The internal Autoretry timer is activated when an overcurrent event condition remains for the blanking timer period ( $t_{BLANK}$ ). The blanking timer resets if the overcurrent condition resolves before  $t_{BLANK}$  has elapsed. During the  $t_{RETRY}$  period, the switch remains OFF. Once  $t_{RETRY}$  has elapsed, the device restarts with  $t_{LIM}$ . If the fault exists, the cycle repeats, and  $t_{RETRY}$  remains asserted. If the overcurrent condition is resolved, the switch stays ON. The  $t_{RETRY}$  pin asserts when the current limit exceeds  $t_{RETRY}$  duration and desserts, when voltage drops across the internal switch, and falls below  $t_{RETRY}$ 

The Autoretry feature reduces system power in case of overcurrent or short-circuit conditions. When the switch is ON during  $t_{BLANK}$  time, the supply current is held at the current limit. During  $t_{RETRY}$  time, there is no current through the switch. Thus, the average output current is much less than the programmed current limit. The average output current can be calculated using the following equation:

$$I_{LOAD} = I_{LIM} \times \frac{t_{BLANK}}{t_{RETRY} + t_{BLANK}}$$

With a 24ms (typ) t<sub>BLANK</sub> and 800ms (typ) t<sub>RETRY</sub>, the duty cycle is 2.9%, resulting in a 97.1% power reduction when compared to the switch being on the entire time. *Figure 14* shows typical behavior in the Autoretry Current-Limit mode.

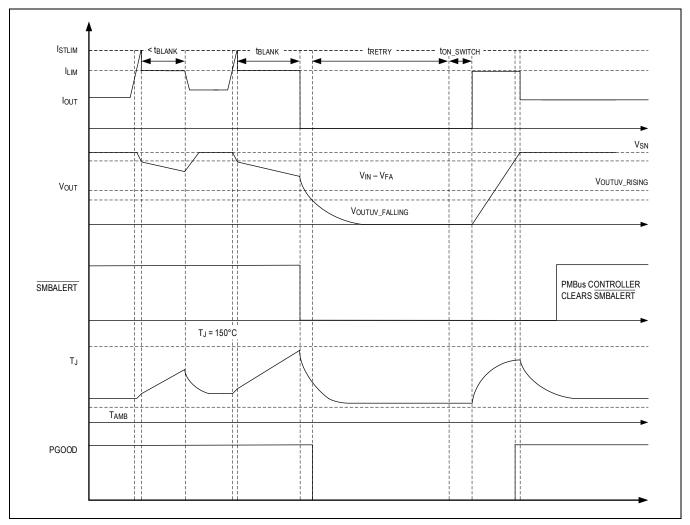


Figure 14. Autoretry Fault Timing Diagram

### **Latch-Off Current Limit**

In Latch-Off current limit mode, the devices remain OFF and latched, if an overcurrent event remains for the blanking timer period (t<sub>BLANK</sub>). The blanking timer resets if the overcurrent condition resolves before t<sub>BLANK</sub> has elapsed. The device operation may be reset by sending the OPERATION command. *Figure 15* shows typical behavior in latch-off current-limit mode.

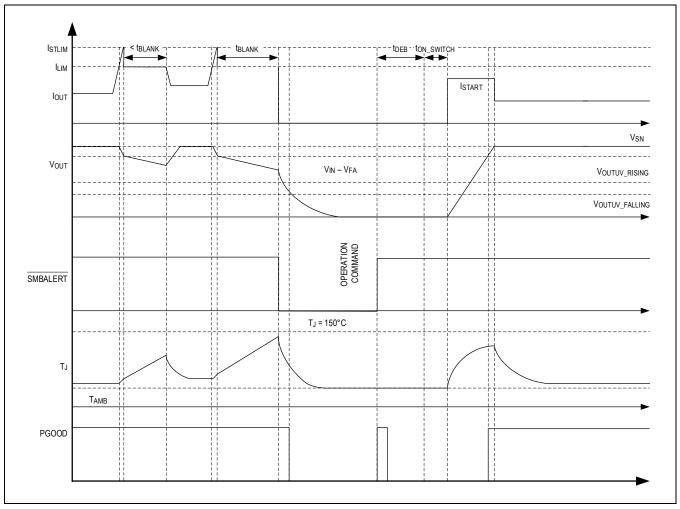


Figure 15. Latch-off Fault Timing Diagram

### **Short Circuit Protection**

During an output short circuit event, the current through the device increases very rapidly. The devices incorporate a fast-trip current comparator to limit the output short circuit peak current. The fast-trip current comparator turns off the internal nFET within 1 $\mu$ s ( $t_{DELAY1}$ ) when the current through the internal FET exceeds  $t_{OCP}$ . The  $t_{OCP}$  is internally set to 30A (typ). After a time delay of 200 $\mu$ s ( $t_{DELAY2}$ ), the device turns back ON and limits the output current to the programmed current limit, and operates as described in earlier current limit mode sections. <u>Figure 16</u> illustrates the behavior of the system when the current exceeds the  $t_{OCP}$  threshold.

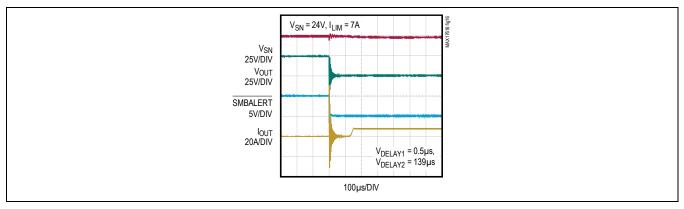


Figure 16. Short Circuit Response

### **Reverse Current Protection**

The reverse current-protection feature is enabled when used with external nFET. The devices prevent reverse current flow from OUT to IN pins.

If a reverse current condition is detected ( $V_{IN} - V_{OUT}$ ) <  $V_{RIB}$ ), the external nFET is turned OFF. When the reverse current condition no longer exists ( $V_{SN} - V_{OUT}$ ) >  $V_{RIB}_{RISING}$ ), the external nFET is turned back ON after ton\_RPSWITCH. If the reverse-current condition is the only fault (no UVLO, no OVLO, no thermal fault, no forward overcurrent fault), then the internal nFET is kept ON. Otherwise, the internal nFET is also turned OFF. <u>Figure 17</u> shows typical behavior in a slow- or fast-reverse-current condition.

The device contains two reverse-current thresholds with slow (20µs typ) and fast (100ns typ) response times for reverse-current protection. The threshold value for slow reverse is -5mV (typ), whereas for fast reverse, it is -100mV (typ). This feature results in robust operation in a noisy environment while still delivering fast protection for a severe fault, such as input short-circuit or hot plug-in at the OUT pins. The SMBALERT pin asserts during a reverse current condition.

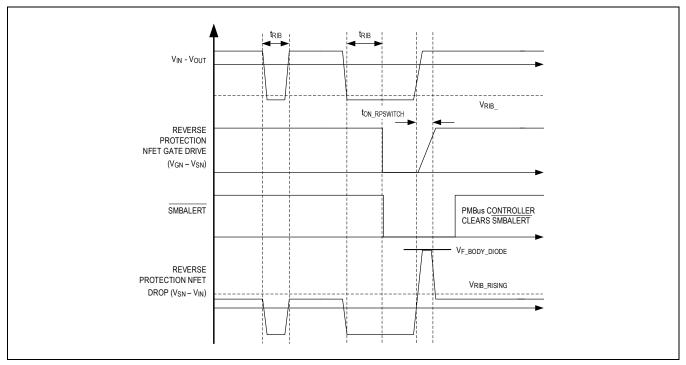


Figure 17. Reverse Current Fault Timing Diagram

### Input Voltage Surge Stopping and Output Overvoltage Feedback Regulation (OVFB)

The MAX17616A offers a surge protection feature whereby the output voltage is limited to a programmable voltage level during input voltage surge events. When the input voltage surges above a set threshold, the output overvoltage feedback loop (OVFB) modulates the drain to source resistance of the internal Control nFET and limits the output voltage. A simplified internal block diagram of the overvoltage clamp function is depicted in *Figure 18*.

There is no timer for the OVFB condition. The part can regulate OUT to be below IN indefinitely, depending on load conditions.

- 1. Part shall operate in OVFB mode as long as no other condition (overcurrent, thermal foldback, etc) kicks in. This is true even if  $(V_{IN} V_{OUT})$  exceeds  $V_{FA}$ , provided only the OVFB condition is present.
- 2. The OVFB condition may trigger t<sub>BLANK</sub> (when a consequential thermal foldback condition kicks in), and the part needs to follow programmed CLMODE after t<sub>BLANK</sub>. As the OVFB threshold is triggered, the V<sub>OUT\_OV\_WARNING</sub> bit of the STATUS VOUT register is set high, and SMBALERT is asserted.

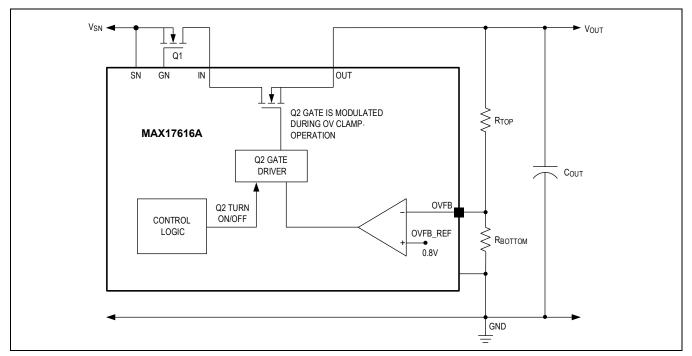


Figure 18. Overvoltage Clamp through OVFB

A typical overvoltage clamp operation and recovery sequence are shown in *Figure 19*.

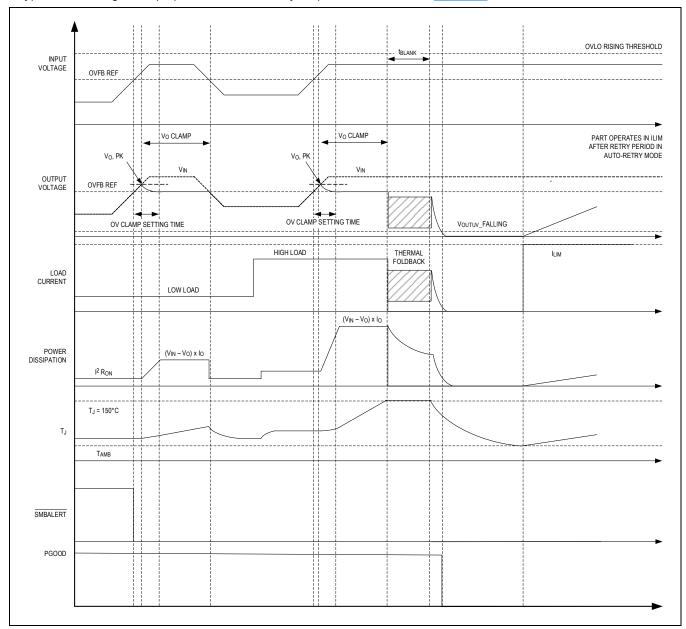


Figure 19. Overvoltage Clamp Operation and Recovery

Figure 20 shows overvoltage clamp response for MAX17616A during an input surge event.

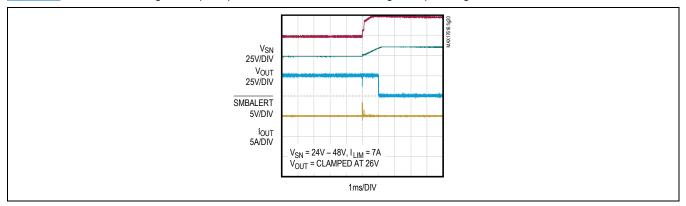


Figure 20. Overvoltage Clamp Response

#### Input Reverse-Polarity Protection

Input reverse-polarity protection is realized using an external nFET that is controlled by MAX17616/MAX17616A. Due to incorrect wiring on the input power supply terminals, a negative supply can appear on the devices' input pins. Connect an external nFET (Q1) with the source connected to the SN pin, drain to the IN pin, and gate to the GN pin, as shown in the *Typical Application Circuits*. During an input reverse polarity voltage fault, this external nFET turns OFF and protects the load. The external nFET is also needed for the optional reverse-current protection. If reverse polarity protection and reverse-current protection are not needed, the SN and GN pins must be connected to the IN pin.

The magnitude of reverse-polarity voltage protection is dependent on the operating load bus voltage ( $V_{OUT}$ ) and the voltage-blocking capability of the external nFET. For example, for protection down to a -55V input voltage with  $V_{OUT}$  = 30V, an external nFET rated for 85V is needed. The devices provide a gate drive (GN) of 6.5V (typ). <u>Figure 21</u> shows the reverse-polarity protection of MAX17616 with  $V_{OUT}$  = 0V and  $V_{SN}$  = -24V. <u>Figure 22</u> shows the reverse-polarity protection of MAX17616 with  $V_{OUT}$  = +24V and  $V_{SN}$  = -24V.

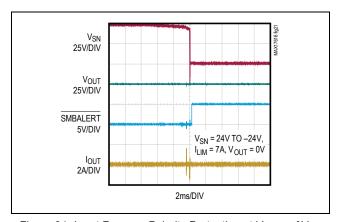


Figure 21. Input Reverse-Polarity Protection at  $V_{OUT} = 0V$ and  $V_{SN} = -24V$ 

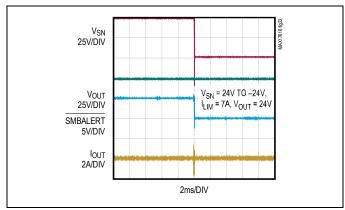


Figure 22. Input Reverse-Polarity Protection at  $V_{OUT}$  = +24V and  $V_{SN}$  = -24V

### **Output Reverse-Polarity Protection**

MAX17616/MAX17616A protects itself and the input-power connections from accidental reverse output-voltage polarity connections. Reverse output voltage can appear across the OUT and GND pins due to inductive loads or incorrect wiring connections of live loads across the output terminals.

<u>Figure 23</u> shows the output reverse-polarity protection of the MAX17616 with  $V_{OUT}$  = -24V and  $V_{SN}$  = 24V and  $V_{SN}$  = 24V and  $V_{SN}$  = 24V and  $V_{SN}$  = 0V. The devices can protect the circuit's negative output voltage up to – (85 –  $V_{IN}$ ) V. <u>Figure 25</u> shows the recovery performance from an output reverse polarity fault condition.

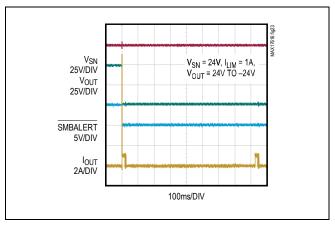


Figure 23. Output Reverse-Polarity Protection with Auto-Retry Mode with  $V_{OUT}$  = -24V and  $V_{SN}$  = 24V

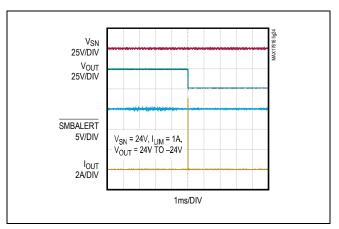


Figure 24. Output Reverse-Polarity Protection with

Auto-Retry Mode with V<sub>OUT</sub> = -24V and V<sub>SN</sub> = 0V

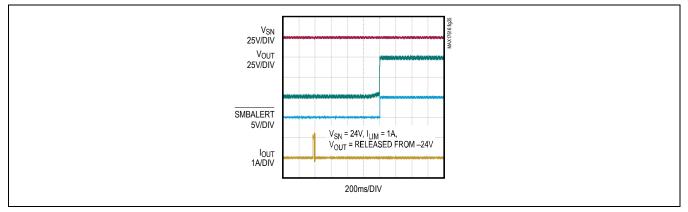


Figure 25. Recovery Performance from an Output Reverse-Polarity Fault with V<sub>OUT</sub> = -24V Initial Condition and V<sub>SN</sub> = 24V

#### Output Undervoltage Sensing (OUTUV)

The devices offer a programmable output undervoltage sensing threshold (OUTUV). When the voltage on the OUT pin falls below the OUTUV falling threshold due to any fault condition, the internal control logic affects a restart cycle with a soft start. If during any fault condition, the output voltage does not fall below the OUTUV falling threshold, then restart cycle is affected without soft-start. This is particularly useful during transient input source fault conditions that do not discharge the output voltage below the programmed OUTUV threshold, where the devices recover without going through a soft-start cycle.

The devices have an OUTUV adjustment range from 3.5V (typ) to 64.8V (typ). OUTUV's rising threshold can be set using the VOUT UV FAULT LIMIT command. OUTUV's falling threshold is 3% below the rising threshold.

### Fault Output (SMBALERT)

The devices offer an open drain fault signal SMBALERT. The fault signal requires an external pullup resistor and bias supply. The SMBALERT pin is asserted low during the following fault conditions:

- Soft Start, when (V<sub>IN</sub> V<sub>OUT</sub>) > V<sub>FA</sub> at the end of t<sub>STO</sub>.
- Overcurrent and short circuit conditions once the current limit exceeds t<sub>BLANK</sub> duration.
- Reverse current condition when Reverse Protection external nFET is turned OFF.
- Thermal Shutdown.
- Input UVLO.
- Input OVLO.

The SMBALERT shall not be deasserted once the above fault conditions observed by the device are cleared. The PMBus Controller needs to clear the SMBALERT signal intentionally by sending the CLEAR\_FAULT command.

<u>Table 2</u> shows the status of the nFETs and the status of the fault signal under various operating conditions.

**Table 2. FETs Status During Faults** 

| CONDITION  | EXTERNAL nFET STATUS | INTERNAL nFET<br>STATUS | SMBALERT STATUS  |
|--|----------------------|-------------------------|--|
| EN Disabled  | OFF                  | OFF                     | High   |
| Normal Operation<br>(No Fault)                                       | ON                   | ON                      | High   |
| Input UVLO   | OFF                  | OFF                     | Low  |
| Input OVLO   | OFF                  | OFF                     | Low  |
| Soft Start<br>(During I <sub>START</sub> /t <sub>STO</sub> period)   | ON                   | ON                      | High   |
| Output Overcurrent   | ON                   | Regulate                | Low<br>(After t <sub>BLANK</sub> )   |
| Short Circuit  | OFF                  | OFF                     | Low  |
| Reverse current with No Other Fault                                  | OFF                  | ON                      | Low  |
| Over Voltage Clamp   | ON                   | Regulate                | Low  |
| Loss of Ground   | OFF                  | OFF                     | High   |
| Output Undervoltage  | ON                   | ON                      | High at power-up until (V <sub>IN</sub> -V <sub>OUT</sub> ) > V <sub>FA</sub> . Low after power-up. <sup>†</sup> |
| Thermal Regulation   | ON                   | Regulate                | High (Automatically low after t <sub>BLANK</sub> due to current regulation)                                      |
| Thermal Shutdown   | OFF                  | OFF                     | Low  |
| SETI Grounded (First Power ON)                                       | OFF                  | OFF                     | Low  |
| $(V_{IN}-V_{OUT}) > V_{FA}$ at the end of $t_{STO}$ (during startup) | OFF                  | OFF                     | Low  |
| PMBus Fault  | OFF                  | OFF                     | Low  |

<sup>†</sup>SMBALERT behavior on OUTUV fault.

When the output voltage falls below the value set in the VOUT\_UV\_FAULT\_LIMIT register, the following functions are required:

- SMBALERT shall be pulled low with no delay.
- · Bit 0 of STATUS\_BYTE is set high.
- · Bit 0 and Bit 15 of STATUS WORD are set high.

- Bit 5 of STATUS VOUT is set high.
- · PGOOD is pulled low.

Startup condition: The assertion of output under-voltage fault shall not be active during startup until the " $(V_{IN} - V_{OUT}) < V_{FA}$ " is reached. This includes not asserting  $\overline{SMBALERT}$  and not registering any bits until the " $(V_{IN} - V_{OUT}) < V_{FA}$ " condition is satisfied. However, PGOOD shall be active during the startup phase. This is required because the downstream electronics would rely on the PGOOD signal to know that the output voltage of MAX17616/MAX17616A is healthy enough to start their operations.

#### Linear Regulator (V<sub>CC</sub>)

The MAX17616/MAX17616A has an internal low dropout (LDO) regulator that powers  $V_{CC}$  from  $V_{IN}$ . This LDO is enabled during power-up or when EN is cycled. The typical  $V_{CC}$  output voltage is 1.8V. Bypass  $V_{CC}$  to GND with a 2.2 $\mu$ F low-ESR ceramic capacitor.

#### **Gate Driver for Reverse Protection External nFET**

The devices offer an integrated gate driver circuit to drive the Reverse Protection external nFET. The gate drive is protected internally from accidental short circuit between the gate and source terminals. The devices provide a gate drive (GN) of 6.5V (typ). The gate drive has passive resistive behavior across gate and source terminals of external nFET when the operation of the devices is disabled by de-asserting EN pin, or through an OPERATION command from the PMBus interface.

If the reverse protection function is not used, and the external nFET is not installed, connect SN and GN terminals to IN pins.

#### **Loss of Ground Protection**

The devices protect loads by turning OFF the internal and external nFETs in a loss-of-ground event. A loss-of-ground event can be caused by a break in connectivity between the ground reference of the system control and the IC ground net around MAX17616/MAX17616A. This feature eliminates the requirement for additional external circuits to protect from loss-of-ground events. Additional components are required for the protection of signal pins (EN, IMON, SMBALERT, PGOOD), as shown in the *Typical Application Circuits*. *Figure 26* shows the typical behavior during a loss-of-ground event.

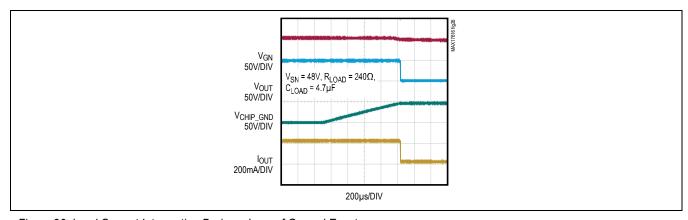


Figure 26. Load Current Interruption During a Loss of Ground Event

### Power Good Output (PGOOD/T<sub>J</sub>)

The devices include a PGOOD comparator to monitor the status of output voltage and to enable/disable the downstream loads. The power good open-drain output requires an external pullup resistor and bias supply. The functionality of PGOOD is explained as follows.

- PGOOD goes high when the output voltage exceeds the OUTUV rising threshold and the (V<sub>IN</sub> V<sub>OUT</sub>) < V<sub>FA</sub> condition is satisfied.
- 2) PGOOD goes low when the output voltage falls below the OUTUV falling threshold.
- 3) At system power-up, PGOOD remains high if V<sub>OUT</sub> > V<sub>OUTUV</sub> and (V<sub>IN</sub> V<sub>OUT</sub>) < V<sub>FA</sub>; otherwise, it is low.

#### Die Temperature Monitoring (PGOOD/T\_J)

The devices offer a die temperature monitoring feature. Connect a  $10k\Omega \sim 20k\Omega$  resistor from PGOOD/T<sub>J</sub> to GND to monitor the internal die temperature on the PGOOD/T<sub>J</sub> pin.

The PGOOD/T<sub>J</sub> pin provides 652mV at 25°C and 854mV at +125°C of die (hot spot) temperature, with a temperature slope of 2mV/°C. The die (hot spot) temperature is expressed using the following equation:

$$V_{TJ} = (T_{DIE} - 25^{\circ}C) \times 2mV + 652mV$$

$$T_{DIE} = \frac{V_{TJ} - 652mV}{2mV} + 25^{\circ}C$$

where,

T<sub>DIF</sub> is the die temperature,

V<sub>TJ</sub> is the voltage at the pin PGOOD/T<sub>J</sub>.

#### **Thermal Shutdown Protection**

The devices have a thermal-shutdown feature to protect against overheating, and a thermal foldback current limit control. When the junction temperature reaches 150°C (typ), the current limit is internally lowered to reduce the power dissipation on the internal nFET, and regulate the junction temperature at around 150°C. In extreme conditions, the devices turn off and assert the SMBALERT pin when the junction temperature exceeds +165°C (typ). The devices exit thermal shutdown and resume normal operation after the junction temperature cools by 20°C (typ), except when in a latch-off mode, where the devices remain latched off.

#### **PMBus Interface**

The devices support the PMBus interface. From a software perspective, the devices can execute a subset of PMBus commands. The devices use the SMBus version 3.1 for transport protocol and respond to the SMBus devices address. In this datasheet, the term SMBus refers to the electrical characteristics of the PMBus communication using the SMBus physical layer. The term PMBus refers to the PMBus command protocol. The devices employ standard SMBus protocols (see *Figure 27*) to read monitored data, warning/faults, and provide access to all manufacturer-specific commands.

Figure 27 uses the following abbreviations:

S: Start Condition

Sr: Repeated Start Condition

P: Stop Condition

R: Read Byte

W: Write Byte

A: Acknowledge Bit

N: Not Acknowledge Bit

The acknowledge bit is active low if the transmitted byte is received successfully by a device. If the receiving device is the bus controller, the acknowledge bit for the last byte read is high and indicated by the N (Not Acknowledge) bit.

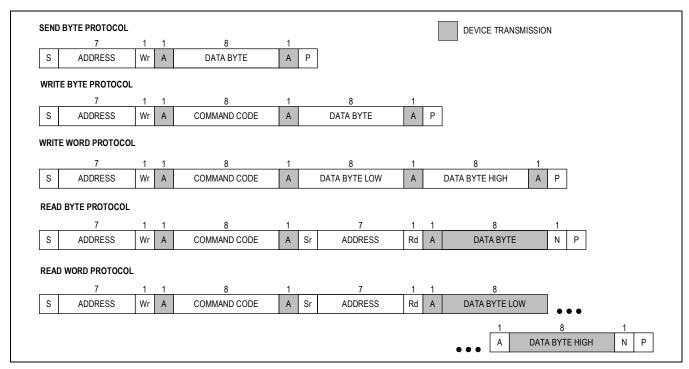


Figure 27. SMBus Command Protocols

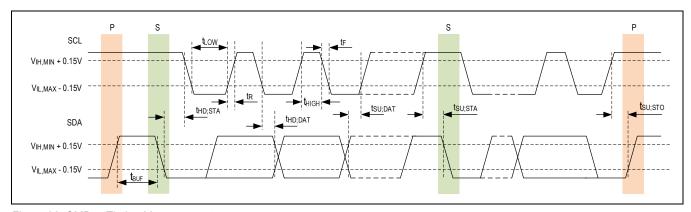


Figure 28. SMBus Timing Measurements

In Power Distribution Architectures with the Controllers powered by an upstream power supply, the devices can be initialized to accept control commands and read commands (See <u>Figure 29</u>). In this architecture, the Controller can Enable and turn ON/OFF the device from the Controller.

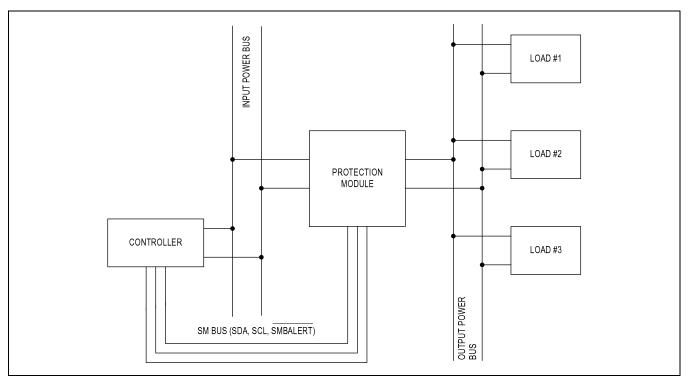


Figure 29. System Architecture

#### **Device Addressing and Reverse Protection (Q1) Decoding**

ADDR/Q1 pin is available for setting the physical PMBus address of the device. The PMBus address is 7 bits long. The upper 3 bits (MSBs) are set as  $001^{\dagger}$ , and the lower four bits can be configured through this pin. During the initial power-up sequence, the ADDR/Q1 pin sends a  $10\mu$ A/400 $\mu$ A current, and the voltage at the ADDR/Q1 pin is sensed to get the value of the resistor connected to the pin. ADDR/Q1 pin is also used to program if the external reverse protection nFET (Q1) is being used or not. Based on the resistor value, the address is set as shown in <u>Table 3</u> (Resistor Values for setting PMBus Address).

Of all the addresses, 00h is reserved for broadcast to all the devices connected to the bus. Hence, 15 devices can be configured with different device addresses on the same bus.

See <u>Table 3</u> for the address set by the pins. Note that the presence or absence of reverse protection nFET (Q1) is not announced on the PMBus physical address. Hence, programming resistors from  $24.3\Omega$  to  $1.87k\Omega$  will give out the same physical PMBus address as programming resistors from  $3.16k\Omega$  to  $86.6k\Omega$ .

<sup>†</sup> The default address space is, therefore, 001.0001 to 001.1111. MSB=000 has been dropped to avoid conflict with reserved ARA address 000.1100.

Table 3. Resistor Values for setting PMBus Address

| RESISTOR VALUE<br>E96 1% [Ω] | LOW NIBBLE IN DECIMAL FORMAT | PMBus ADDRESS | EXTERNAL REVERSE<br>PROTECTION NFET Q1 |
|------------------------------|------------------------------|---------------|--|
| RESERVED FOR BROADCAST       |                              | 0000000       | _                                      |
| 24.3                         | 1                            | 0010001       | No                                     |
| 78.7                         | 2                            | 0010010       | No                                     |
| 147.0                        | 3                            | 0010011       | No                                     |
| 226.0                        | 4                            | 0010100       | No                                     |
| 309.0                        | 5                            | 0010101       | No                                     |
| 402.0                        | 6                            | 0010110       | No                                     |
| 499.0                        | 7                            | 0010111       | No                                     |
| 604.0                        | 8                            | 0011000       | No                                     |
| 732.0                        | 9                            | 0011001       | No                                     |
| 866.0                        | 10                           | 0011010       | No                                     |
| 1000                         | 11                           | 0011011       | No                                     |
| 1210                         | 12                           | 0011100       | No                                     |
| 1400                         | 13                           | 0011101       | No                                     |
| 1620                         | 14                           | 0011110       | No                                     |
| 1870                         | 15                           | 0011111       | No                                     |
| 3160                         | 1                            | 0010001       | Yes                                    |
| 5760                         | 2                            | 0010010       | Yes                                    |
| 9090                         | 3                            | 0010011       | Yes                                    |
| 12400                        | 4                            | 0010100       | Yes                                    |
| 16200                        | 5                            | 0010101       | Yes                                    |
| 20000                        | 6                            | 0010110       | Yes                                    |
| 24300                        | 7                            | 0010111       | Yes                                    |
| 28700                        | 8                            | 0011000       | Yes                                    |
| 34800                        | 9                            | 0011001       | Yes                                    |
| 41200                        | 10                           | 0011010       | Yes                                    |
| 48700                        | 11                           | 0011011       | Yes                                    |
| 56200                        | 12                           | 0011100       | Yes                                    |
| 64900                        | 13                           | 0011101       | Yes                                    |
| 75000                        | 14                           | 0011110       | Yes                                    |
| 86600                        | 15                           | 0011111       | Yes                                    |

#### **DIRECT Data Format**

The devices use DIRECT Data format to report input voltage, output voltage, output current, and temperature. The DIRECT format is used for any value:

$$X = \frac{1}{m} \; x \; (Y. \, 10^{-R} - b)$$

where

X is the real-world value.

Y is a two-byte 2's complement integer sent over the bus.

m is the slope coefficient, a two-byte 2's complement integer.

b is the offset, a two-byte 2's complement integer.

R is the exponent, a one-byte 2's complement integer.

Output data is a 2-byte word, the first 12 bits of which contain the Y value that can be converted into the real-world quantity by using the above formula and the following coefficients:

|                                     | UNIT | m    | R  | b     | MAX ERROR <sup>1</sup> |
|-------------------------------------|------|------|----|-------|------------------------|
| V <sub>IN</sub> or V <sub>OUT</sub> | V    | 512  | -1 | -18   | 3.5% @ 3V              |
| I <sub>OUT</sub> <sup>2</sup>       | Α    | 5845 | -1 | 80    | 6% @ 0.7A              |
| Die Temperature                     | °C   | 71   | -1 | 19653 | 9°C @ 25°C             |

<sup>&</sup>lt;sup>1</sup> includes analog readout, ADC conversion (10bit ENOB), and DIRECT conversion.

#### **PMBus Commands**

The devices support the following subset of commands defined in the Power System Management Protocol Specification Part II – Command Language Revision 1.3.1. For detailed specifications and the complete list of PMBus commands, refer to Part II of the PMBus specification available at *pmbus.org*.

Table 4. PMBus Commands used in MAX17616 and MAX17616A

| COMMAND | COMMAND NAME        | COMMAND DESCRIPTION  | TRANSACTION<br>TYPE                          | NO. OF<br>BYTES | SCALING<br>FACTOR (N) |
|---------|---------------------|--|--|-----------------|-----------------------|
| 01h     | OPERATION           | Retrieves or stores the operation status.  | R/W Byte                                     | 1               | -                     |
| 03h     | CLEAR_FAULTS        | Clears any fault bits that have been set. This command clears all bits in all status registers simultaneously. |  | 0               | I                     |
| 19h     | CAPABILITY          | Retrieves the device capability.   | Read Byte                                    | 1               | I                     |
| 1Bh     | SMBALERT_MASK       | Stores SMBALERT fault mask.  | Block<br>Write-Block<br>Read Process<br>Call | 1               | 1                     |
| 44h     | VOUT_UV_FAULT_LIMIT | Retrieves or stores output undervoltage fault threshold.   | R/W Byte                                     | 1               | -                     |
| 78h     | STATUS_BYTE         | Returns one-byte information about the part operating status.  | Read Byte                                    | 1               | -                     |

 $<sup>^{2}</sup>$  current is measured as voltage on IMON pin. The considered range is 124.8mV to 1.25V, corresponding to 0.7A to 7A with  $R\_IMON = 3.8kΩ$ .

## MAX17616/MAX17616A

# 3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

| COMMAND | COMMAND NAME        | COMMAND DESCRIPTION   | TRANSACTION<br>TYPE | NO. OF<br>BYTES | SCALING<br>FACTOR (N) |
|---------|---------------------|---|---------------------|-----------------|-----------------------|
| 79h     | STATUS_WORD         | Returns two bytes of information with a summary of the fault conditions.  | Read Word           | 2               | _                     |
| 7Ah     | STATUS_VOUT         | Returns one byte of information about the status of the output voltage.   | Read Byte           | 1               | -                     |
| 7Bh     | STATUS_IOUT         | Returns one byte of information about the status of the output current.   | Read Byte           | 1               | _                     |
| 7Ch     | STATUS_INPUT        | Returns one byte of information about the status of the input.            | Read Byte           | 1               | _                     |
| 7Dh     | STATUS_TEMPERATURE  | Returns one byte of information about the status of the temperature.      | Read Byte           | 1               | _                     |
| 7Eh     | STATUS_CML          | Retrieves information about communications status.                        | Read Byte           | 1               | _                     |
| 80h     | STATUS_MFR_SPECIFIC | Returns two bytes of information about specific fault conditions.         | Read Byte           | 1               | -                     |
| 88h     | READ_VIN            | Returns measured input voltage value on SN pin.                           | Read Word           | 2               | See Note 1            |
| 8Bh     | READ_VOUT           | Returns measured output voltage value on OUT pin.                         | Read Word           | 2               | See Note 1            |
| 8Ch     | READ_IOUT           | Returns measured output current   | Read Word           | 2               | See Note 1            |
| 8Dh     | READ_TEMPERATURE_1  | Returns measured temperature value.                                       | Read Word           | 2               | See Note 1            |
| 98h     | PMBus_REVISION      | Returns revision of PMBus specification to which the device is compliant. | Read Byte           | 1               | -                     |
| 99h     | MFR_ID              | Returns manufacturer ID in ASCII.   | Read Byte           | 6               | _                     |
| 9Ah     | MFR_MODEL           | Returns part number in ASCII.   | Read Byte           | 10              | -                     |
| 9Bh     | MFR_REVISION        | Returns part revision letter or number in ASCII.                          | Read Byte           | 3               | -                     |
| C4h     | SET_CLMODE          | Retrieves or stores the response mode during a fault.                     | R/W Byte            | 1               | -                     |
| C5h     | SET_ISTART_RATIO    | Retrieves or stores ISTART_RATIO value.                                   | R/W Byte            | 1               | _                     |
| C6h     | SET_TSTOC           | Retrieves or stores the short-term overcurrent limit time.                | R/W Byte            | 1               | -                     |
| C7h     | SET_ISTLIM          | Retrieves or stores the short-term overcurrent limit.                     | R/W Byte            | 1               | _                     |
| ADh     | IC_DEVICE_ID        |   | Read Byte           | 10              |                       |
| AEh     | IC_DEVICE_REV       |   | Read Byte           | 3               |                       |

Note 1: See the <u>DIRECT Data</u> Format Section.

#### MAX17616/MAX17616A

3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

#### **OPERATION**

Command Code: 01h
Number of data bytes: 1
Number of bits used: 1/8
Protocol: Read Byte/Write Byte

The OPERATION command is used to configure the operational state of the controller, if the EN pin is high. The OPERATION command turns the PMBus device output on and off with commands sent over the PMBus.

| EN PIN | BIT<br>NUMBER |       |        |  |          |                   |  |  |  |  | DEVICE STATE/<br>RESPONSE | INTERNAL CIRCUITRY OF<br>MAX17616/MAX17616A | PMBus<br>INTERFACE | Q1/Q2 STATUS |
|--------|---------------|-------|--------|--|----------|-------------------|--|--|--|--|---------------------------|---|--------------------|--------------|
|        | 7             | [6:0] | ON/OFF |  |          |                   |  |  |  |  |                           |   |                    |              |
| LOW    | Х             | XX    | OFF    | Low I <sub>Q</sub> mode;<br>Control circuits OFF | Disabled | OFF               |  |  |  |  |                           |   |                    |              |
| HIGH   | 0             | XX    | OFF    | Normal operation                                 | Active   | OFF               |  |  |  |  |                           |   |                    |              |
| HIGH   | 1             | XX    | ON     | Normal operation                                 | Active   | Operation enabled |  |  |  |  |                           |   |                    |              |

If a PMBus device receives an OPERATION command data byte that attempts to configure or operate the device in an unsupported manner, then the device shall treat this as invalid data and declare a communications fault.

Bits [6:0] shall be set to 0000000 internally. Bit [7] shall be set to 1 as default.

#### **CLEAR\_FAULT**

Command Code: 03h
Number of data bytes: N/A
Number of bits used: N/A
Protocol: Send Byte

The CLEAR\_FAULTS command is used to clear any fault bits that have been set. This command clears all bits in all status registers simultaneously. At the same time, the device negates (clears, releases) its SMBALERT signal output if the device is asserting the SMBALERT signal.

The CLEAR\_FAULTS command does not cause a unit that has latched off for a fault condition to restart. Units that have shut down for a fault condition are restarted.

If the fault is still present when the bit is cleared, the fault bit shall immediately be set again, and the host will be notified by the usual means.

This command is write only. There is no data byte for this command.

#### **CAPABILITY**

Command Code: 19h
Number of data bytes: 1
Number of bits used: 4/8
Protocol: Read Byte

This command provides a way for a host system to determine some key capabilities of the device. The CAPABILITY command returns the information about the device, as shown in the following table.

| BITS | DESCRIPTION MEANING  |   | DEFAULT VALUE |
|------|--|---|---------------|
| 7    | Packet Error Checking The bit is set to 1 if Packet Error Checking (PEC) is supported. |   | 1             |
| 6:5  | Maximum Bus Speed  | 00: 100kHz<br>01: 400kHz<br>10: 1MHz<br>11: Reserved  | 10            |
| 4    | SMBALERT   | The bit is set to 1 if the device has an SMBALERT pin and supports the SMBus Alert response protocol. | 1             |
| 3:0  | _  | Not supported.  | 0000          |

#### SMBALERT\_MASK

Command Code: 1BhNumber of data bytes: 1Number of bits used: 8/8

Protocol: Block Write-Block Read Process Call

The SMBALERT\_MASK command may be used to prevent a warning or fault condition from asserting the SMBALERT signal.

The command format is used to block a status bit or bits from causing the SMBALERT signal to be asserted, as shown in <u>Figure 30</u>. The bits in the mask byte align with the bits in the corresponding status register. For example, if the STATUS\_TEMPERATURE command code were sent with the mask byte 01000000b, then an overtemperature warning condition would be blocked from asserting SMBALERT.

|  | s | DEVICE ADDRESS | W | А | SMBALERT_MASK<br>COMMAND CODE | А | STATUS_X<br>COMMAND CODE | А | MASK BYTE | А | Р |
|--|---|----------------|---|---|-------------------------------|---|--------------------------|---|-----------|---|---|
|--|---|----------------|---|---|-------------------------------|---|--------------------------|---|-----------|---|---|

Figure 30. Block Write-Block Read Process Call

## VOUT\_UV\_FAULT\_LIMIT

Command Code: 44hNumber of data bytes: 1Data Format: bit\_field

• Protocol: Read Byte/Write Byte

The VOUT\_UV\_FAULT\_LIMIT command sets or retrieves the undervoltage threshold on output in voltage. See the following table to set the values for the OUTUV threshold.

| BITS | DESCRIPTION                             | MEANING  | DEFAULT VALUE |
|------|---|--|---------------|
| 7:5  | NA                                      |  |               |
| 4:2  | Nominal voltage selection               | 000 5V<br>001 9V<br>010 12V<br>011 24V<br>100 36V<br>101 48V<br>110 60V<br>111 72V | 000           |
| 1:0  | PGOOD <b>rising</b> threshold selection | 00 -10%<br>01 -20%<br>10 -30%  | 00            |

The OUTUV falling threshold will be automatically set 3% below the rising one.

#### STATUS\_BYTE

Command Code: 78h
Number of data bytes: 1
Number of bits used: 6/8
Protocol: Read Byte

The STATUS\_BYTE command returns one byte of information with a summary of the unit's fault condition. Based on the information in this byte, the host can get more information by reading the appropriate status registers.

The STATUS\_BYTE message content is shown in the following table:

| BIT | NAME          | MEANING  |
|-----|---------------|--|
| 7   | BUSY          | A fault was declared because the device was busy and unable to respond. Not used. Reserved bit.                                      |
| 6   | OFF           | This bit is asserted if the unit is not providing power to the output, regardless of the reason, including simply not being enabled. |
| 5   | VOUT_OV_FAULT | An output over-voltage fault has occurred. Not used.   |
| 4   | IOUT_OC_FAULT | An output over-current fault has occurred.   |
| 3   | VIN_UV_FAULT  | An input under-voltage fault has occurred.   |
| 2   | TEMPERATURE   | A temperature fault or warning has occurred.   |
| 1   | CML           | A communications, memory, or logic fault has occurred.   |
| 0   | NONE OF ABOVE | A fault or warning not listed in bits [7:1] of this byte has occurred.   |

#### STATUS\_WORD

Command Code: 79h

Number of data bytes: 2Number of bits used: 11/16Protocol: Read Word

The STATUS\_WORD command returns two bytes of information with a summary of the unit's fault condition. Based on the information in these bytes, the host can get more information by reading the appropriate status registers.

The STATUS\_WORD message content is shown in the following table:

| BYTE | BIT            | NAME          | MEANING  |
|------|----------------|---------------|--|
|      | 7              | BUSY          | A fault was declared because the device was busy and unable to respond. Not used. Reserved bit.                                      |
|      | 6              | OFF           | This bit is asserted if the unit is not providing power to the output, regardless of the reason, including simply not being enabled. |
|      | 5              | VOUT_OV_FAULT | An output over-voltage fault has occurred. Not used.   |
| LOW  | 4              | IOUT_OC_FAULT | An output over-current fault has occurred.   |
|      | 3 VIN_UV_FAULT |               | An input under-voltage fault has occurred.   |
|      | 2              | TEMPERATURE   | A temperature fault or warning has occurred.   |
|      | 1              | CML           | A communications, memory, or logic fault has occurred.   |
|      | 0              | NONE OF ABOVE | A fault or warning not listed in bits [7:1] of this byte has occurred.   |

| BYTE | BIT | NAME                               | MEANING  |
|------|-----|------------------------------------|--|
|      | 7   | V <sub>OUT</sub>                   | An output voltage fault or warning has occurred.   |
|      | 6   | I <sub>OUT</sub> /P <sub>OUT</sub> | An output current or output power fault or warning has occurred.   |
|      | 5   | INPUT                              | An input voltage, input current, or input power fault or warning has occurred.                                     |
|      | 4   | MFR                                | A manufacturer-specific fault or warning has occurred.   |
| HIGH | 3   | POWER_GOOD                         | Not supported, always 0.   |
|      | 2   | FANS                               | Not supported, always 0.   |
|      | 1   | OTHER                              | Not supported, always 0.   |
|      | 0   | STARTUP                            | Asserted during STARTUP (before $V_{OUT}$ reaches $V_{IN}$ - $V_{FA}$ ), it is set to 0 after STARTUP is complete. |

Note: The IOUT\_OC\_FAULT and I<sub>OUT</sub>/P<sub>OUT</sub> bits shall be set only after a delay of t<sub>STOC</sub>.

#### STATUS\_VOUT

Command Code: 7Ah
Number of data bytes: 1
Number of bits used: 2/8
Protocol: Read Byte

The STATUS\_VOUT command returns one byte of information with a summary of the unit's output voltage fault condition. The STATUS\_VOUT message content is shown in the following table:

| BIT | NAME                | MEANING  |
|-----|---------------------|--|
| 7   | VOUT_OV_FAULT       | Not supported, always 0.   |
| 6   | VOUT_OV_WARNING     | An output regulation event has occurred (valid only with the OVFB part variant). |
| 5   | VOUT_UV_WARNING     | Output has gone below the OUTUV threshold.                                       |
| 4   | VOUT_UV_FAULT       | Not supported, always 0.   |
| 3   | VOUT_MAX_WARNING    | Not supported, always 0.   |
| 2   | TON_MAX_FAULT       | Not supported, always 0.   |
| 1   | TOFF_MAX_WARNING    | Not supported, always 0.   |
| 0   | VOUT Tracking Error | Not supported, always 0.   |

#### STATUS\_IOUT

Command Code: 7Bh
Number of data bytes: 1
Number of bits used: 2/8
Protocol: Read Byte

The STATUS\_IOUT command returns one data byte with information about the fault conditions related to the output current.

The STATUS\_IOUT message content is shown in the following table:

| BIT | MEANING  |
|-----|--|
| 7   | An output overcurrent fault has occurred.  |
| 6   | An output overcurrent and low voltage fault has occurred simultaneously.  (output overcurrent = part entered current limit operation, Low voltage fault = UVLO fault). |
| 5   | An output overcurrent warning has occurred (I <sub>LIM</sub> < I <sub>OUT</sub> < I <sub>STLIM</sub> ). Not used.  |
| 4   | Not supported, always 0.   |
| 3   | Not supported, always 0.   |
| 2   | Not supported, always 0.   |
| 1   | Not supported, always 0.   |
| 0   | Not supported, always 0.   |

Note: During an overcurrent fault, bits [7:6] shall be set only after a delay of  $t_{STOC}$ . During an overcurrent fault, bit [5] shall be set when the OUT current exceeds  $l_{LIM}$ .

#### STATUS\_INPUT

Command Code: 7Ch
Number of data bytes: 1
Number of bits used: 2/8
Protocol: Read Byte

The STATUS\_INPUT command returns one byte of information with a summary of the unit's input fault condition.

The STATUS\_INPUT message content is shown in the following table:

| BIT | NAME                                       | MEANING                                    |
|-----|--|--|
| 7   | VIN_OV_FAULT                               | An input over-voltage fault has occurred.  |
| 6   | VIN_OV_WARNING                             | Not supported, always 0.                   |
| 5   | VIN_UV_WARNING                             | Not supported, always 0.                   |
| 4   | VIN_UV_FAULT                               | An input under-voltage fault has occurred. |
| 3   | Unit Off for Insufficient<br>Input Voltage | Not supported, always 0.                   |
| 2   | IIN_OC_FAULT                               | Not supported, always 0.                   |
| 1   | IIN_OC_WARNING                             | Not supported, always 0.                   |
| 0   | PIN_OP_WARNING                             | Not supported, always 0.                   |

#### STATUS\_TEMPERATURE

Command Code: 7Dh
Number of data bytes: 1
Number of bits used: 1/8
Protocol: Read Byte

The STATUS\_TEMPERATURE command returns one byte of information with a summary of the unit's temperature fault condition.

The STATUS\_TEMPERATURE message content is shown in the following table:

| BIT | NAME       | MEANING                                 |
|-----|------------|---|
| 7   | OT_FAULT   | An over-temperature fault has occurred. |
| 6   | OT_WARNING | Not supported, always 0.                |
| 5   | UT_WARNING | Not supported, always 0.                |
| 4   | UT_FAULT   | Not supported, always 0.                |
| 3   | Reserved   | Not supported, always 0.                |
| 2   | Reserved   | Not supported, always 0.                |
| 1   | Reserved   | Not supported, always 0.                |
| 0   | Reserved   | Not supported, always 0.                |

### STATUS\_CML

Command Code: 7Eh
Number of data bytes: 1
Number of bits used: 5/8
Protocol: Read Byte

The STATUS\_CML command returns one data byte with information about the fault conditions related to communication. The STATUS\_CML message content is shown in the following table:

| BIT | MEANING  |
|-----|--|
| 7   | Invalid or unsupported Command Received.                                     |
| 6   | Invalid or unsupported Data Received.  |
| 5   | Packet Error Check Failed.   |
| 4   | Memory Error Detected.   |
| 3   | Not supported.   |
| 2   | Not supported.   |
| 1   | A communication fault other than the ones listed in this table has occurred. |
| 0   | Not supported.   |

#### STATUS\_OTHER

Command Code: 7Fh
Number of data bytes: 1
Number of bits used: 0/8
Protocol: Read Byte

This command is used to identify the device that asserted SMBALERT first. Not supported. For future use always 0.

#### STATUS\_MFR\_SPECIFIC

Command Code: 80h
Number of data bytes: 1
Number of bits used: 4/8
Protocol: Read Byte

The STATUS\_MFR\_SPECIFIC command returns one data byte with information about specific fault conditions shown in the following table:

| BIT | MEANING                                     |
|-----|---|
| 7   | SETI Pin fault.                             |
| 6   | IMON Pin fault. Not supported.              |
| 5   | The soft start failed.                      |
| 4   | Not Used.                                   |
| 3   | An output short circuit fault has occurred. |
| 2   | A reverse current fault has occurred.       |
| 1   | Not supported, always 0.                    |
| 0   | Not supported, always 0.                    |

Note: Bit [7:6] shall be set only after a delay of tSTOC, after an overcurrent fault.

#### **READ VIN**

Command Code: 88h
Number of data bytes: 2
Data Format: DIRECT
Protocol: Read Word

The READ\_VIN command returns the input voltage measured at the SN pin in Volt. The two data bytes are encoded in DIRECT format.

The input voltage range is 3V to 80V. See the *Direct Data Format* section for input voltage scaling.

#### READ\_VOUT

Command Code: 8Bh
Number of data bytes: 2
Data Format: DIRECT
Protocol: Read Word

The READ\_VOUT command returns the actual, measured output voltage at the OUT pin in Voltage. The two data bytes are encoded in DIRECT format.

The output voltage range is 3V to 80V. See the DIRECT Data Format section for output voltage scaling.

#### READ\_IOUT

Command Code: 8Ch
Number of data bytes: 2
Data Format: DIRECT
Protocol: Read Word

The READ\_IOUT command returns the measured current across the internal control nFET in A. The two data bytes are encoded in DIRECT format.

The output current range is 0A to 7A. See the *Direct Data Format* section for output current scaling.

#### MAX17616/MAX17616A

3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

#### READ\_TEMPERATURE\_1

Command Code: 8Dh
Number of data bytes: 2
Data Format: DIRECT
Protocol: Read Word

The READ\_TEMPERATURE\_1 command returns the measured output temperature in degrees Celsius. The two data bytes are encoded in DIRECT format.

The temperature range is -40°C to +150°C. See the <u>Direct Data Format</u> section for temperature scaling.

#### PMBus\_REVISION

Command Code: 98h
Number of data bytes: N/A
Number of bits used: N/A
Protocol: Read Byte

PMBus\_REVISION command stores or reads the revision of the PMBus to which the device is compliant.

The command has one data byte. Bits [7:4] indicate the revision of PMBus specification Part I to which the device is compliant. Bits [3:0] indicate the revision of PMBus specification Part II to which the device is compliant. The command returns 33h, which corresponds to Revision 1.3 of Part I and Part II.

#### MFR\_ID

Command Code: 99hNumber of data bytes: 6Protocol: Read Byte

The MFR\_ID command is used to either set or read the manufacturer's ID (name, abbreviation, or symbol that identifies the unit's manufacturer). Each manufacturer chooses their identifier. MFR\_ID is typically only set once at the time of manufacture.

The MFR\_ID for the MAX17616/MAX17616A is "0x 05 4D 41 58 49 4D".

#### MFR MODEL

Command Code: 9AhNumber of data bytes: 10Protocol: Read Byte

The MFR\_MODEL command is used to either set or read the manufacturer's model number. MFR\_MODEL is typically set once, at the time of manufacture.

The manufacturer ID for the MAX17616 is "0x 09 4D 41 58 31 37 36 31 36 20".

The manufacturer ID for the MAX17616A is "0x 09 4D 41 58 31 37 36 31 36 41".

#### MFR\_REVISION

Command Code: 9BhNumber of data bytes: 3Protocol: Read Byte

The MFR\_REVISION command is used to either set or read the manufacturer's revision number. Each manufacturer uses the format of their choice for the revision number. MFR\_REVISION is typically set at the time of manufacture or if the device is updated to a later revision.

The model review for the MAX17616/MAX17616A is "02 30 31".

#### IC\_DEVICE\_ID

Command Code: ADhNumber of data bytes: 10Protocol: Read-only Byte

The IC\_DEVICE\_ID command is used to read the manufacturer's model number.

The manufacturer ID for the MAX17616 is "0x 09 4D 41 58 31 37 36 31 36 20".

The manufacturer ID for the MAX17616A is "0x 09 4D 41 58 31 37 36 31 36 41".

#### IC\_DEVICE\_REV

Command Code: AEhNumber of data bytes: 3Protocol: Read-only Byte

The IC\_DEVICE\_REV command is used to read the manufacturer's revision number. Each manufacturer uses the format of their choice for the revision number.

The model review for the MAX17616/MAX17616A is "02 30 31".

#### SET\_CLMODE

Command Code: C4h
Number of data bytes: 1
Number of bits used: 2/8
Protocol: Read Byte/Write Byte

The SET\_CLMODE mode command is used to set the mode of operation during a fault. For Auto-retry mode, [7:6] is set to 0b10. For Latch-off mode, bit [7:6] is set to 0b00. For Continuous mode, bit [7:6] is set to 0b01.

Bit [5:0] are set to 0. The default value of bits [7:6] is set to 0b10.

#### SET\_ISTART\_RATIO

Command Code: C5h
Number of data bytes: 1
Number of bits used: 4/8
Protocol: Read byte/Write byte

The SET\_ISTART\_RATIO command is used to set the current limit ratio during start-up, as a function of the current limit (ILIM) programmed using the SETI pin resistor. See the following table to set the current limit ratio:

| BIT [7:3] | BIT [3:0] | CURRENT LIMIT DURING START-UP              |
|-----------|-----------|--|
| XXXXX     | 000       | I <sub>LIM</sub>                           |
| XXXXX     | 001       | I <sub>LIM</sub> x 1/2                     |
| XXXXX     | 010       | I <sub>LIM</sub> x 1/4 [Default selection] |
| XXXXX     | 011       | I <sub>LIM</sub> x 1/8                     |
| XXXXX     | 100       | I <sub>LIM</sub> x 1/16                    |

#### SET\_TSTOC

Command Code: C6h
Number of data bytes: 1
Number of bits used: 2/8
Protocol: Read Byte/Write Byte

The SET\_TSTOC mode command is used to set the time for the short-term overcurrent limit. See the following table to set tstoc.

| BIT [7:2] | BIT [1:0] | tsтос                     |
|-----------|-----------|---------------------------|
| xxxxxx    | 00        | 400μs [Default selection] |
| xxxxxx    | 01        | 1ms                       |
| xxxxxx    | 10        | 4ms                       |
| xxxxxx    | 11        | 24ms                      |

#### **SET ISTLIM**

Command Code: C7h
Number of data bytes: 1
Number of bits used: 2/8
Protocol: Read Byte/Write Byte

The SET\_ISTLIM mode command is used to set the short-term overcurrent limit ratio. See the following table to set ISTLIM.

| BIT [7:2] | BIT [1:0] | ISTLIM                     |
|-----------|-----------|----------------------------|
| xxxxxx    | 00        | 1.25:1                     |
| xxxxxx    | 01        | 1.50:1                     |
| xxxxxx    | 10        | 1.75:1                     |
| xxxxxx    | 11        | 2.00:1 [Default selection] |

#### **Fault Management**

For reporting faults/warnings to the controller on a real-time basis, the MAX17616 and MAX17616A assert the open-drain SMBALERT pin and set the appropriate bit in the STATUS\_WORD register. SMBALERT is used in conjunction with the SMBus Alert Response Address (ARA).

On recognition of the SMBALERT assertion, the controller is expected to access all devices through an Alert Response Address (ARA). Only the device(s) that pulled SMBALERT low will acknowledge the Alert Response Address. The host performs a modified Receive Byte operation. The 7-bit device address provided by the device transmit device is placed in the 7 most significant bits of the byte. The eighth bit can be a zero or one.

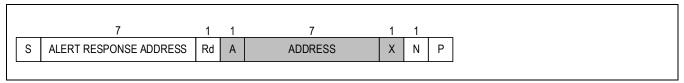


Figure 31. A 7-Bit Addressable Device Response to an ARA



Figure 32. A 7-Bit Addressable Device Response to an ARA with PEC

If more than one device pulls  $\overline{\text{SMBALERT}}$  low, the highest priority (lowest address) device will win communication rights via standard arbitration during the device address transfer. After receiving an acknowledge bit from the controller in response to its address, that device must stop pulling down on the  $\overline{\text{SMBALERT}}$  signal. If the host still sees  $\overline{\text{SMBALERT}}$  low when the message transfer is complete, it knows to read the ARA again. A host that does not implement the  $\overline{\text{SMBALERT}}$  signal may periodically access the ARA.

Faults/warnings are cleared when any CLEAR\_FAULTS command is received.

See the following table to see the fault mapping:

| COMMAND        | ВІТ | NAME             | INPUT UVLO | INPUT OVLO | OUTPUT UVLO | OVFB | OUTPUT OVERCURRENT (VFA) | REVERSE<br>CURRENT | SHORT CIRCUIT<br>(I <sub>OUT</sub> > OCP) | THERMAL<br>SHUTDOWN | SETI FAULT | PMBUS FAULT | ОТНЕК    |
|----------------|-----|------------------|------------|------------|-------------|------|--------------------------|--------------------|---|---------------------|------------|-------------|----------|
|                | 15  | V <sub>OUT</sub> |            |            | х           | х    |                          |                    |   |                     |            |             |          |
|                | 14  | louт/Роит        |            |            |             |      | х                        |                    |   |                     |            |             |          |
|                | 13  | INPUT            | х          | Х          |             |      |                          |                    |   |                     |            |             |          |
|                | 12  | MFR              |            |            |             |      |                          | Х                  | Х   |                     | Х          |             |          |
|                | 11  | POWER_GOOD       |            |            |             |      |                          |                    |   |                     |            |             | NOT USED |
|                | 10  | FANS             |            |            |             |      |                          |                    |   |                     |            |             | NOT USED |
|                | 9   | OTHER            |            |            |             |      |                          |                    |   |                     |            |             | NOT USED |
| STATUS         | 8   | UNKNOWN          |            |            |             |      |                          |                    |   |                     |            |             | NOT USED |
| WORD           | 7   | BUSY             |            |            |             |      |                          |                    |   |                     |            |             | NOT USED |
|                | 6   | OFF              |            |            |             |      |                          |                    |   |                     |            |             |          |
|                | 5   | VOUT_OV_FAULT    |            |            |             |      |                          |                    |   |                     |            |             |          |
|                | 4   | IOUT_OC_FAULT    |            |            |             |      | х                        |                    |   |                     |            |             |          |
|                | 3   | VIN_UV_FAULT     | х          |            |             |      |                          |                    |   |                     |            |             |          |
|                | 2   | TEMPERATURE      |            |            |             |      |                          |                    |   | х                   |            |             |          |
|                | 1   | CML              |            |            |             |      |                          |                    |   |                     |            | Х           |          |
|                | 0   | NONE OF ABOVE    |            | Х          | х           | х    |                          | х                  | х   |                     | Х          |             |          |
|                | 7   | BUSY             |            |            |             |      |                          |                    |   |                     |            |             | NOT USED |
| STATUS<br>BYTE | 6   | OFF              |            |            |             |      |                          |                    |   |                     |            |             |          |
| . –            | 5   | VOUT_OV_FAULT    |            |            |             |      |                          |                    |   |                     |            |             |          |

| and i wibus     |     |  |            |            |             |      |                          |                    |   |         |            |             |          |
|-----------------|-----|--|------------|------------|-------------|------|--------------------------|--------------------|---|---------|------------|-------------|----------|
| COMMAND         | ВІТ | NAME   | INPUT UVLO | INPUT OVLO | OUTPUT UVLO | OVFB | OUTPUT OVERCURRENT (VFA) | REVERSE<br>CURRENT | SHORT CIRCUIT<br>(I <sub>OUT</sub> > OCP) | THERMAL | SETI FAULT | PMBUS FAULT | ОТНЕК    |
|                 | 4   | IOUT_OC_FAULT                                    |            |            |             |      | х                        |                    |   |         |            |             |          |
|                 | 3   | VIN_UV_FAULT                                     | х          |            |             |      |                          |                    |   |         |            |             |          |
|                 | 2   | TEMPERATURE                                      |            |            |             |      |                          |                    |   | х       |            |             |          |
|                 | 1   | CML  |            |            |             |      |                          |                    |   |         |            | х           |          |
|                 | 0   | NONE OF ABOVE                                    |            | х          | х           | х    |                          | х                  | х   |         | х          |             |          |
|                 | 7   | VOUT_OV_FAULT                                    |            |            |             |      |                          |                    |   |         |            |             |          |
|                 | 6   | VOUT_OV_<br>WARNING                              |            |            |             | х    |                          |                    |   |         |            |             |          |
|                 | 5   | VOUT_UV_<br>WARNING                              |            |            | х           |      |                          |                    |   |         |            |             |          |
| STATUS<br>VOUT  | 4   | VOUT_UV_FAULT                                    |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
| V001            | 3   | VOUT_MAX_MIN                                     |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 2   | TON_MAX_FAULT                                    |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 1   | TOFF_MAX_<br>WARNING                             |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 0   | VOUT Tracking Error                              |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 7   | VIN_OV_FAULT                                     |            | х          |             |      |                          |                    |   |         |            |             |          |
|                 | 6   | VIN_OV_WARNING                                   |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 5   | VIN_UV_WARNING                                   |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 4   | VIN_UV_FAULT                                     | х          |            |             |      |                          |                    |   |         |            |             |          |
|                 | 3   | Unit Off For<br>Insufficient Input<br>Voltage    |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
| STATUS<br>INPUT | 2   | IIN_OC_FAULT<br>(Input Overcurrent<br>Fault)     |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 1   | IIN_OC_WARNING<br>(Input Overcurrent<br>Warning) |            |            |             |      |                          |                    |   |         |            |             | NOT USED |
|                 | 0   | PIN_OP_WARNING<br>(Input Overpower<br>Warning)   |            |            |             |      |                          |                    |   |         |            |             | NOT USED |

|                           |     |  |            |            |             |      |                          |                    |   |                     |            |             | 3 Interface   |
|---------------------------|-----|--|------------|------------|-------------|------|--------------------------|--------------------|---|---------------------|------------|-------------|---|
| COMMAND                   | ВІТ | NAME   | INPUT UVLO | INPUT OVLO | OUTPUT UVLO | OVFB | OUTPUT OVERCURRENT (VFA) | REVERSE<br>CURRENT | SHORT CIRCUIT<br>(l <sub>OUT</sub> > OCP) | THERMAL<br>SHUTDOWN | SETI FAULT | PMBUS FAULT | ОТНЕК   |
|                           | 7   | Output overcurrent fault                       |            |            |             |      | х                        |                    |   |                     |            |             | After<br>T <sub>BLANK</sub>                                     |
|                           | 6   | Output overcurrent and low-voltage fault       |            |            | x           |      |                          |                    |   |                     |            |             | Set when<br>Output<br>overcurrent<br>and Output<br>undervoltage |
|                           | 5   | Output overcurrent warning                     |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
| STATUS IOUT               | 4   | Output undercurrent fault                      |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
|                           | 3   | Current share fault                            |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
|                           | 2   | The device is operating in power-limiting mode |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
|                           | 1   | Output overpower fault                         |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
|                           | 0   | Output overpower warning                       |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
|                           | 7   | SETI fault                                     |            |            |             |      |                          |                    |   |                     | х          |             |   |
|                           | 6   | Not Used                                       |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
|                           | 5   | Not Used                                       |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
| STATUS<br>MFR             | 4   | Not Used                                       |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
| SPECIFIC                  | 3   | Output Short Circuit                           |            |            |             |      |                          |                    | Х   |                     |            |             |   |
|                           | 2   | Reverse Current                                |            |            |             |      |                          | х                  |   |                     |            |             |   |
|                           | 1   | RFU  |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
|                           | 0   | RFU  |            |            |             |      |                          |                    |   |                     |            |             | NOT USED  |
| STATUS<br>TEMPERATU<br>RE | 7   | OT_FAULT<br>(Overtemperature<br>Fault)         |            |            |             |      |                          |                    |   | х                   |            |             |   |

| COMMAND       | ВІТ | NAME  | INPUT UVLO | INPUT OVLO | OUTPUT UVLO | OVFB | OUTPUT OVERCURRENT (VFA) | REVERSE<br>CURRENT | SHORT CIRCUIT<br>(I <sub>OUT</sub> > OCP) | THERMAL<br>SHUTDOWN | SETI FAULT | PMBUS FAULT | ОТНЕК    |
|---------------|-----|---|------------|------------|-------------|------|--------------------------|--------------------|---|---------------------|------------|-------------|----------|
|               | 6   | OT_WARNING<br>(Overtemperature<br>Warning)                                  |            |            |             |      |                          |                    |   |                     |            |             | NOT USED |
|               | 5   |   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 4   |   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 3   |   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 2   |   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 1   |   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 0   |   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 7   | Invalid or<br>Unsupported<br>Command Received                               |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 6   | Invalid or<br>Unsupported Data<br>Received                                  |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 5   | Packet Error Check<br>Failed  |            |            |             |      |                          |                    |   |                     |            |             |          |
| STATUS<br>CML | 4   | Memory Error<br>Detected  |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 3   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 2   | (Reserved, per PMBus specification)   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 1   | A communication fault other than the ones listed in this table has occurred |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 0   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 7   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 6   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
| STATUS        | 5   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
| OTHER         | 4   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 3   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 2   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |
|               | 1   | _   |            |            |             |      |                          |                    |   |                     |            |             |          |

| COMMAND                            | ВІТ | NAME                                      | INPUT UVLO | INPUT OVLO | OUTPUT UVLO | OVFB | OUTPUT OVERCURRENT (VFA) | REVERSE<br>CURRENT | SHORT CIRCUIT<br>(I <sub>OUT</sub> > OCP) | THERMAL<br>SHUTDOWN | SETI FAULT | PMBUS FAULT | ОТНЕК                                   |
|------------------------------------|-----|---|------------|------------|-------------|------|--------------------------|--------------------|---|---------------------|------------|-------------|---|
|                                    | 0   | First to assert SMBALERT                  |            |            |             |      |                          |                    |   |                     |            |             | Not<br>Supported.<br>For future<br>use. |
| SMBALERT                           | Pin | Assert SMBALERT Open-Drain to Low status  | х          | х          | х           | х    | х                        | х                  | х   | х                   | х          | x           |   |
| t <sub>BLANK</sub> for<br>SMBALERT |     | Blanking Time before pulling SMBALERT Low | 0s         | 0s         | 0s          | 0s   | <sup>t</sup> BLANK       | 0s                 | 0s  | 0s                  | 0s         | 0s          |   |

### **Applications Information**

#### **IN Capacitor**

A 1µF capacitor from the IN pin to GND is recommended to hold input voltage during sudden load-current changes.

#### Hot Plug-In at IN Terminal

In many powering applications, an input-filtering capacitor is required to lower the radiated emission and enhance the ESD capability. In hot plug-in applications, parasitic cable inductance, and the input capacitor cause overshoot and ringing when a live power cable is connected to the input terminal.

This effect causes the protection device to see almost twice the applied voltage. A transient voltage suppressor (TVS) is often used in industrial applications to protect the system from these conditions. A TVS that can limit surge voltage to a maximum of 80V shall be placed close to the input terminals for enhanced protection.

#### **Input Hard Short to Ground**

In many system applications, an input short-circuit protection is required. The device detects reverse current entering at the OUT pin and flowing out of the IN pin and turns off the external nFET. The magnitude of the reverse current depends on the inductance of the input circuitry and any capacitance installed near the IN pins.

#### **Voltage Interruption Response**

MAX17616/MAX17616A features fast recovery after voltage interruption during input-supply brownout tests. The device takes 150µs (typ) to turn on the internal nFET and 100µs (typ) to start turning on the external nFET when recovering from a brownout fault. *Figure 33* illustrates the performance of voltage interruption and recovery response.

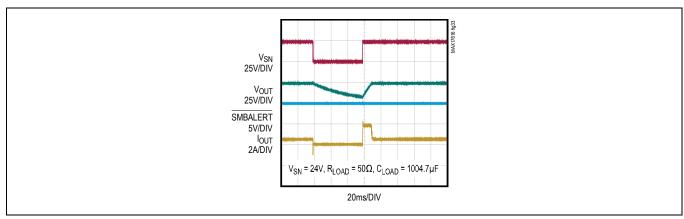


Figure 33. Voltage Interruption Response

#### **OUT Capacitor**

The maximum capacitive load ( $C_{MAX}$ ) that can be connected is a function of the current-limit setting ( $I_{LIM}$  in A), the startup timeout ( $I_{STO}$  in ms), and the input voltage ( $I_{SN}$ ). The  $I_{CMAX}$  is calculated using the following equation:

$$C_{MAX} (mF) = \frac{I_{LIM} x t_{STO}}{V_{SN}}$$

For example, for  $V_{SN}$  = 24V,  $t_{STO}$  (typ) = 1200ms, and  $I_{LIM}$  = 1A,  $C_{MAX}$  is 50mF

Output capacitor values over C<sub>MAX</sub> can trigger false overcurrent conditions. Note that the above equation assumes that no-load current is drawn from the OUT pins. Any load current drawn would offset the capacitor charging current, resulting in a large charging period and, hence, the possibility of a false overcurrent condition.

In practical applications, the  $C_{MAX}$  value is limited by the thermal performance of the Printed Circuit Board (PCB). Poor thermal design can cause the thermal foldback current-limiting function of the device to kick in too early, which can further limit the maximum capacitance that can be charged. Therefore, a good thermal PCB design is imperative for charging large capacitor banks.

#### Hot Plug-In at OUT Terminal

In some applications, an external voltage at the OUT terminal of the devices can be applied with or without the presence of an input voltage. During these conditions, the devices detect any reverse current entering the OUT pin, flowing out of the IN pin, and turn off the external nFET. Parasitic cable inductance, along with input and output capacitors, cause overshoot and ringing when an external voltage is applied at the OUT terminal. This causes the protection devices to see up to twice the applied voltage, which can damage the devices. It is recommended to maintain overvoltages such that the voltages at the pins do not exceed the *Absolute Maximum Ratings*.

#### **OUT Clamping Diode for inductive Hard Short to Ground**

In applications that require protection from a sudden short to ground with an inductive load or a long cable, an output clamp is recommended. This clamp can be implemented with a TVS, and a diode as shown in the  $\underline{Typical\ Application\ Circuits}$ . This is required to clamp the negative spike on the OUT pin due to the inductive kickback during an output short-circuit event within the safe operating region. The maximum negative clamping voltage of the TVS for a maximum input voltage of  $V_{INMAX}$  is limited to  $(80 - V_{INMAX})$  V to ensure IN to OUT pin voltage does not exceed 80V.

#### **Layout and Thermal Dissipation**

Place input and output capacitors as close as possible to the device. The IN and OUT pins must be connected with wide, short traces to the power bus. During normal operation, the power dissipation is small, and the package temperature change is minimal.

Power dissipation under steady-state normal operation may be calculated as:

$$P_{SS} = I_{OUT}^2 \times R_{ON}$$

See the <u>Electrical Characteristics Table</u> and <u>Typical Operating Characteristics</u> for R<sub>ON</sub> values at various operating temperatures. Thermal vias from the exposed pad to the ground plane should be used to provide adequate heatsinking to internal ground planes.

#### **ESD Protection**

No capacitor is required for ±2kV (type) (HBM) ESD on IN. All pins have ±2kV (HBM) ESD protection. In applications in which an external nFET is used, see the IN Capacitor section.

<u>Figure 34</u> shows the Human Body Model and <u>Figure 35</u> shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the device through a  $1.5k\Omega$  resistor.

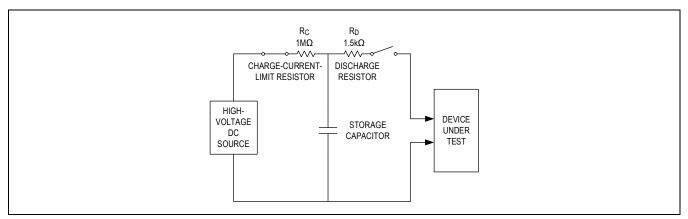


Figure 34. Human Body ESD Test Model

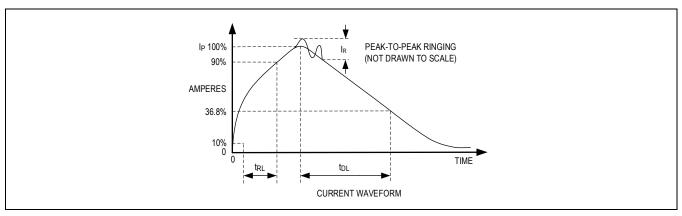
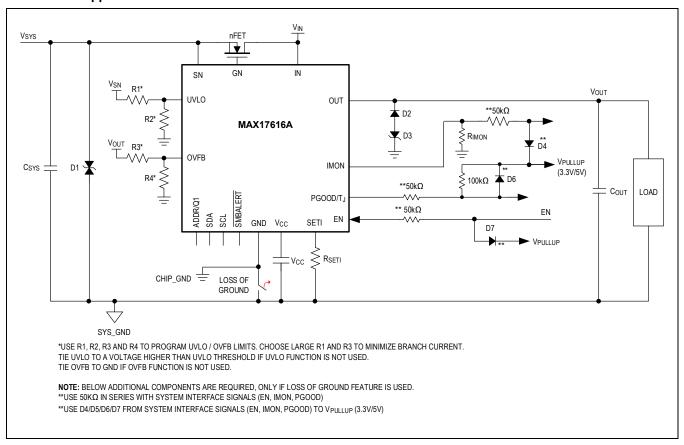


Figure 35. Human Body Current Waveform

## **Typical Application Circuits**

#### **MAX17616A Application Circuit**



## **Ordering Information**

| PART NUMBER    | TEMP RANGE      | PIN-PACKAGE  | FEATURES    |
|----------------|-----------------|--------------|-------------|
| MAX17616AFD+   | -40°C to +125°C | 23-Pin FCQFN | PMBus, OVLO |
| MAX17616AFD+T  | -40°C to +125°C | 23-Pin FCQFN | PMBus, OVLO |
| MAX17616AAFD+  | -40°C to +125°C | 23-Pin FCQFN | PMBus, OVFB |
| MAX17616AAFD+T | -40°C to +125°C | 23-Pin FCQFN | PMBus, OVFB |

<sup>+</sup>Denotes a lead (Pb)-free/RoHS-compliant package.

T = Tape and reel.

#### MAX17616/MAX17616A

3V to 80V, 7A, Current-Limiter with OV/Surge, UV, Reverse Polarity, Loss of Ground Protection and PMBus Interface

## **Revision History**

| REVISION<br>NUMBER | REVISION DATE | DESCRIPTION     | PAGES<br>CHANGED |
|--------------------|---------------|-----------------|------------------|
| 0                  | 10/24         | Initial release | _                |

